

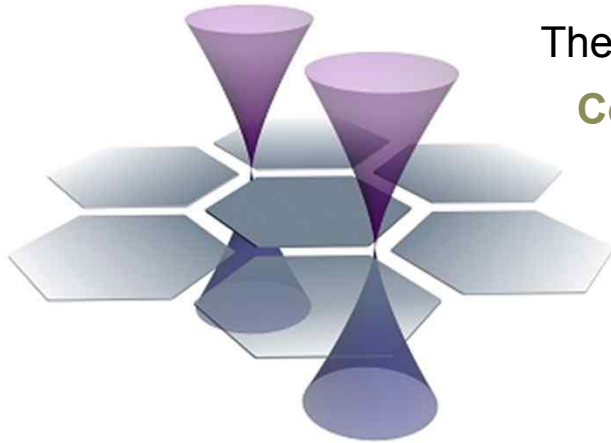
2D FETs with MoS₂, WSe₂, and black phosphorous toward practical electronics

Seongil Im

E-mail: semicon@yonsei.ac.kr

Lab. Website: [Http://edlab.yonsei.ac.kr](http://edlab.yonsei.ac.kr)

Introduction



The most **widely studied** 2-D material

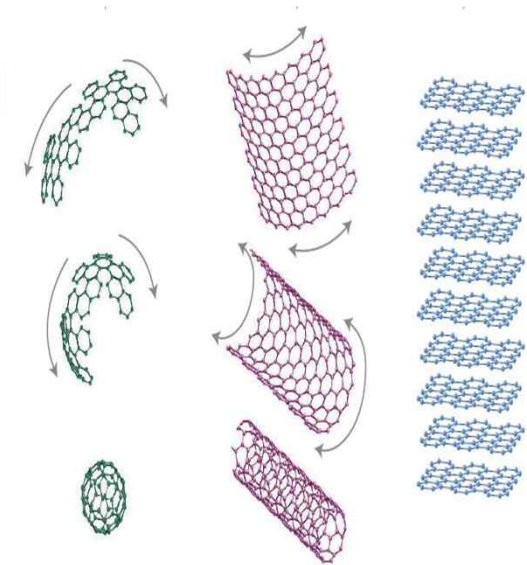
Conical Dirac spectrum

Energy states **without a bandgap**

High mobility ($< 100000\text{cm}^2/\text{Vs}$)

More **conductive** than copper

Attractive **optical** phenomena



More **Flexible** than rubber

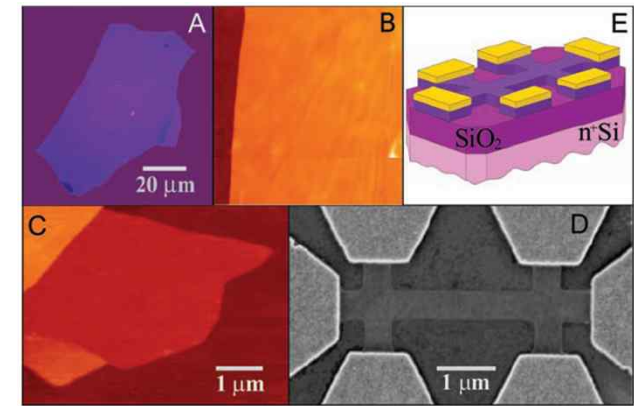
Stretchable material

Stronger than diamond

Various formation (ribbon, tube, ball...)



K. S. Kim *Nature* 457, 706 (2009)



K. S. Novoselov et al. *Science* 306, 666 (2004)

Limitation of Graphene

Gapless Band Structure → Unsuitable for **switching devices**

Transition Metal Dichalcogenides

Transition Metal Dichalcogenides (MX_2)

Similar storyline of the **graphene family**

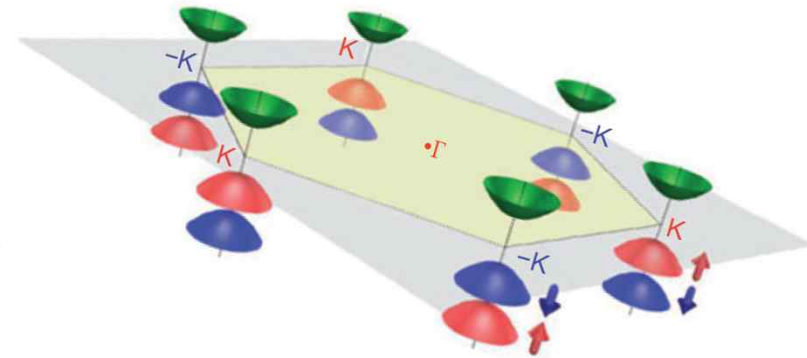
2D and **layered** (thin-film) structures

Covalently bonded X-M-X

held together by **Van der Waals** interactions.

Broken symmetry in atomic basis

↳ can make **Band Gap** of ~ 1 eV



M. Chhowala et al. *Nature Chem.* **5**, 263 (2013)

	$-\text{S}_2$	$-\text{Se}_2$	$-\text{Te}_2$
Nb	Metal	Metal	Metal
Ta	Metal	Metal	Metal
Mo	Semiconducting (1L : 1.8eV, Bulk : 1.2eV)	Semiconducting (1L : 1.5eV, Bulk : 1.1eV)	Semiconducting (1L : 1.1eV, Bulk : 1.0eV)
W	Semiconducting (1L : 1.9eV, Bulk : 1.4eV)	Semiconducting (1L : 1.7eV, Bulk : 1.2eV)	Semiconducting (1L : 1.1eV)

modified version of Q. H. Wang et al. *Nature Nanotech.* **7**, 699 (2012)

Recent Progress on 2D Nanosheet in World Researches

FET –countless many reports (e.g. A. Kis in Nat Nano. 2011)

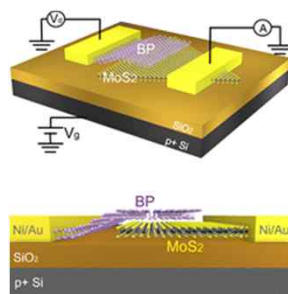
1. Field-Effect Transistors Built from All Two-Dimensional Material Components, *ACS Nano*, **8**, 6259 (2014)
2. Impact of Contact on the Operation and Performance of Back-Gated Monolayer MoS₂ Field-Effect-Transistors, *ACS Nano*, **9**, 7904 (2015)
3. Highly Stable, Dual-Gated MoS₂ Transistors Encapsulated by Hexagonal Boron Nitride with Gate-Controllable Contact, Resistance, and Threshold Voltage, *ACS Nano*, **9**, 7019 (2015)

CMOS –several reports

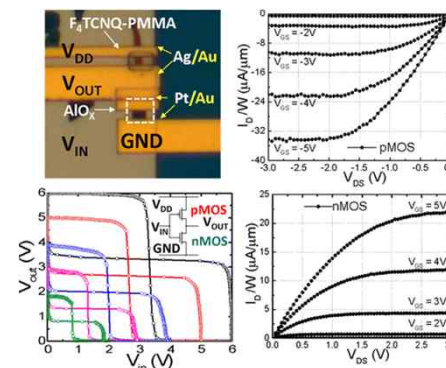
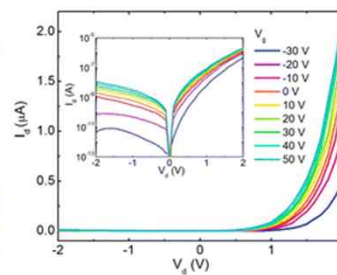
1. High gain, low noise, fully complementary logic inverter based on bi-layer WSe₂ field effect transistors, *Appl. Phys. Lett.*, **105**, 083511 (2014)
2. High Gain Inverters Based on WSe₂ Complementary Field-Effect Transistors, *ACS Nano*, **8**, 4948 (2014)
3. High-Performance WSe₂ Complementary Metal Oxide Semiconductor Technology and Integrated Circuits, *Nano Letters*, **15**, 4928 (2015)

pn diode-several reports

1. Dual-Gated MoS₂/WSe₂ van der Waals Tunnel Diodes and Transistors, *ACS Nano*, **9**, 2071 (2015)
2. Black Phosphorus–Monolayer MoS₂ van der Waals Heterojunction p–n Diode, *ACS Nano*, **8**, 8292 (2014)
3. Epitaxial growth of a monolayer WSe₂-MoS₂ lateral p-n junction with an atomically sharp interface, *Science*, **249**, 524 (2015)
4. Vertical Heterostructure of Two-Dimensional MoS₂ and WSe₂ with Vertically Aligned Layers, *Nano Letters*, **15**, 1031 (2015)
5. Lateral epitaxial growth of two-dimensional layered semiconductor heterojunctions, *Nat. Nanotechnol.*, **9**, 1024 (2014)



ACS Nano, **8**, 8292 (2014)



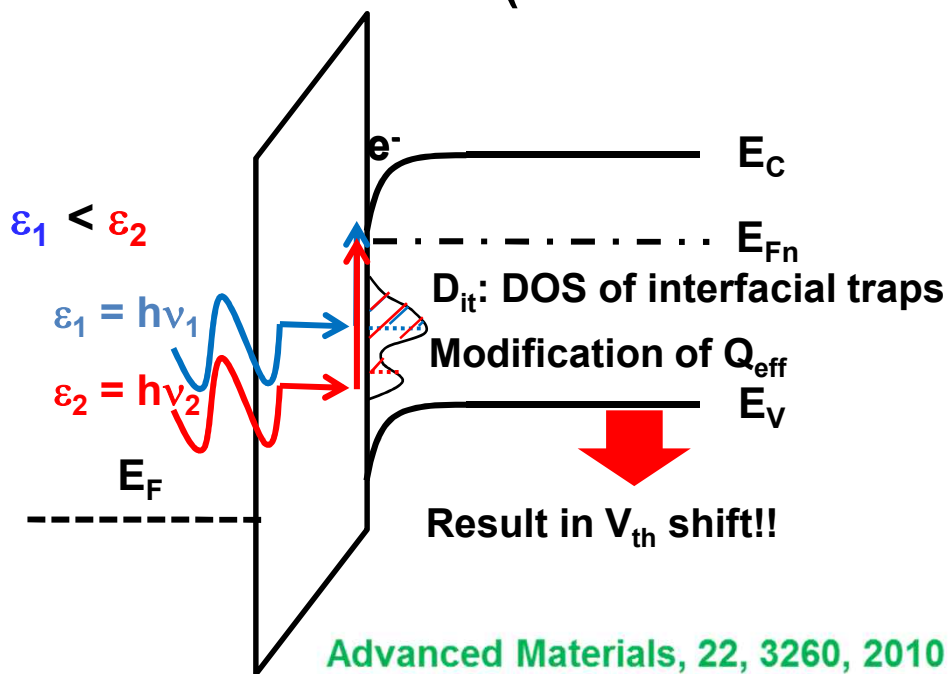
Nano Letters, **15**, 4928 (2015)

Outline

- **Introduction : Outline and Motivation**
 - **Progress on 2D Nanosheets in **World Researches****
-
- **Progress on 2D Nanosheets in **our Lab****
 - **Top-gate MoS₂ FET, Nonvolatile Memory FETs and P-N diode**
 - **2D-2D, 2D-1D, 2D-Organic **Hybrid Complementary Inverter****
 - **Black Phosphorous **Dual Gate FETs****
 - **NiOx-MoS₂ van der Waals junction **MESFET****
 - **Summary**

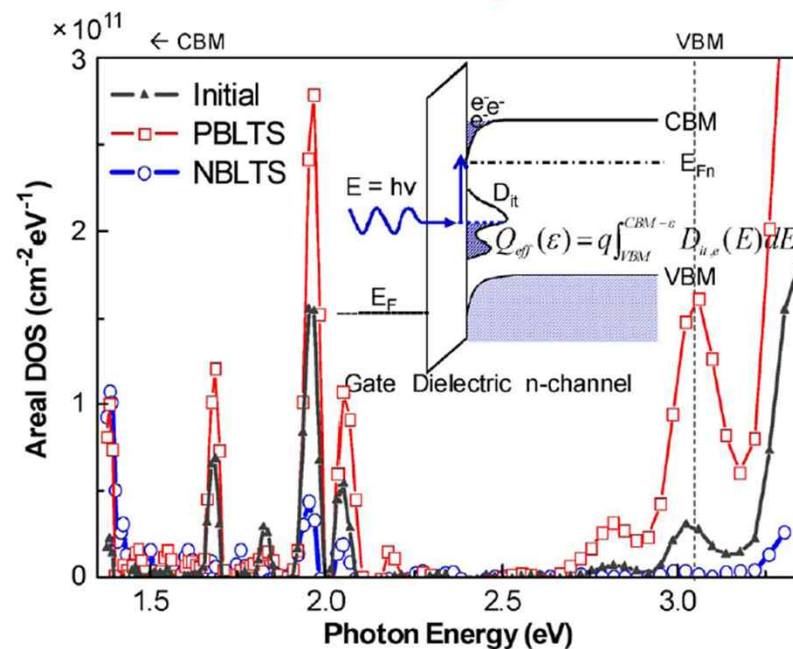
Photo-Excited Charge Collection Spectroscopy

For n-channel FET (i. e. oxide semiconductor)



Gate Dielectric n-channel

IGZO LG Display



Making on-state
(accumulation)



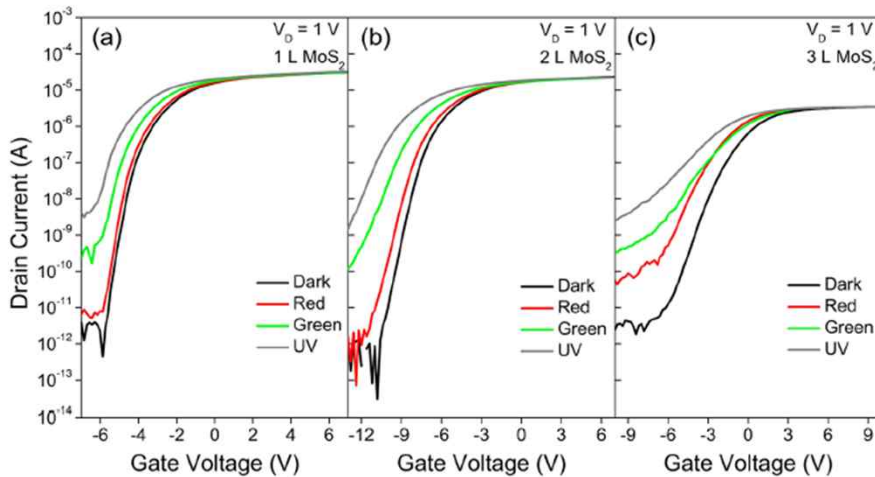
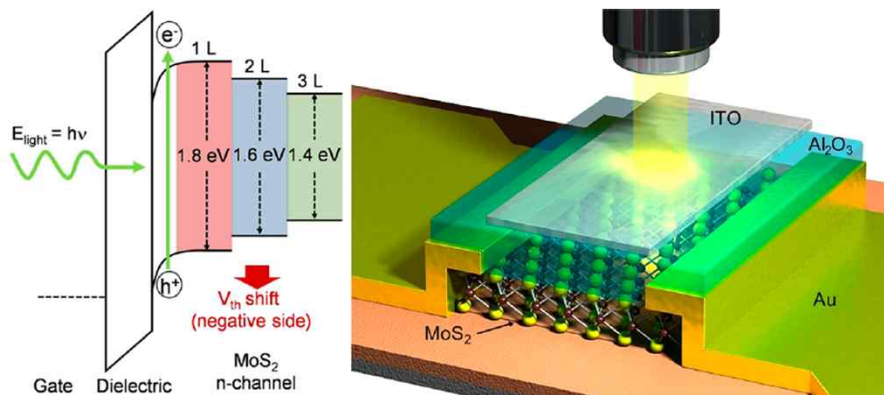
All interfacial (electron) traps
are occupied...

$$\Delta V_{th}(\epsilon) \Rightarrow \Delta Q_{eff} = C \Delta V_{th} \Rightarrow D_{it}(CBM - \epsilon) = \frac{C_{ox}}{q} \frac{\partial V_{th}(\epsilon)}{\partial \epsilon}$$

Recent Progress on 2D Nanosheet (IM)

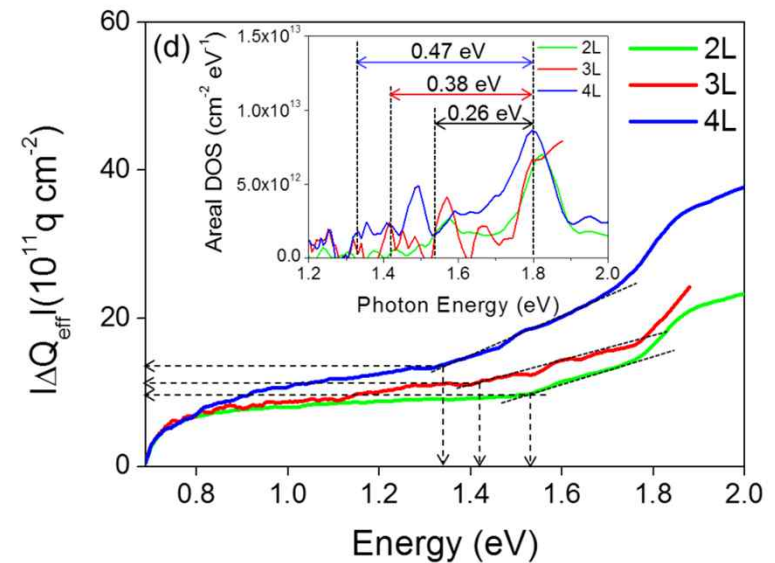
1. Nanosheet Band-Gap & Thickness Modulation

MoS₂ Nanosheet Phototransistors with Thickness-modulated Optical Energy Gap, *Nano Lett.* (2012)



2. Nanosheet-Dielectric Interface Trap

Trap density probing on top-gate MoS₂ Nanosheet field-effect transistors by photo-excited charge collection spectroscopy, *Nanoscale* (2015)

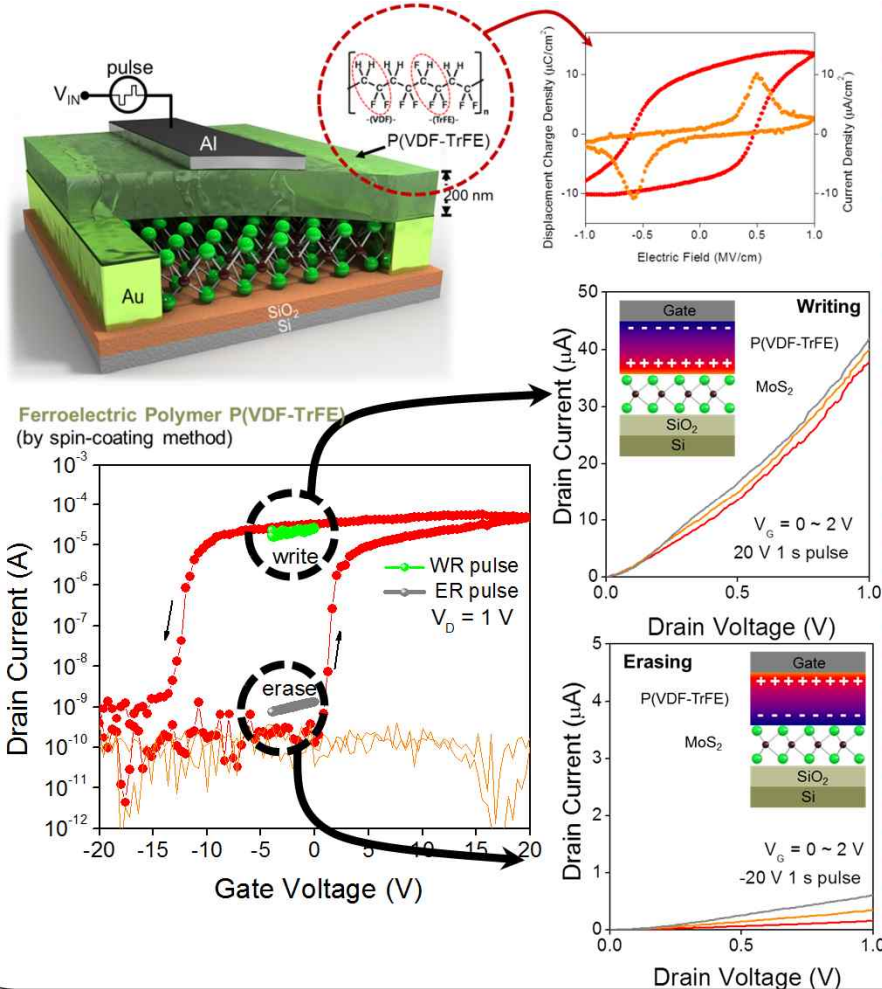


Number of MoS ₂ layer	Trap density (X10 ¹² cm ⁻²) obtained from			
	Hysteresis	PECCS	Hysteresis & PECCS	SS
2	1.92	1.00	2.92	6.67
3	1.26	1.15	2.41	7.10
4	2.47	1.37	3.84	7.69

Recent Progress on 2D Nanosheet (IM)

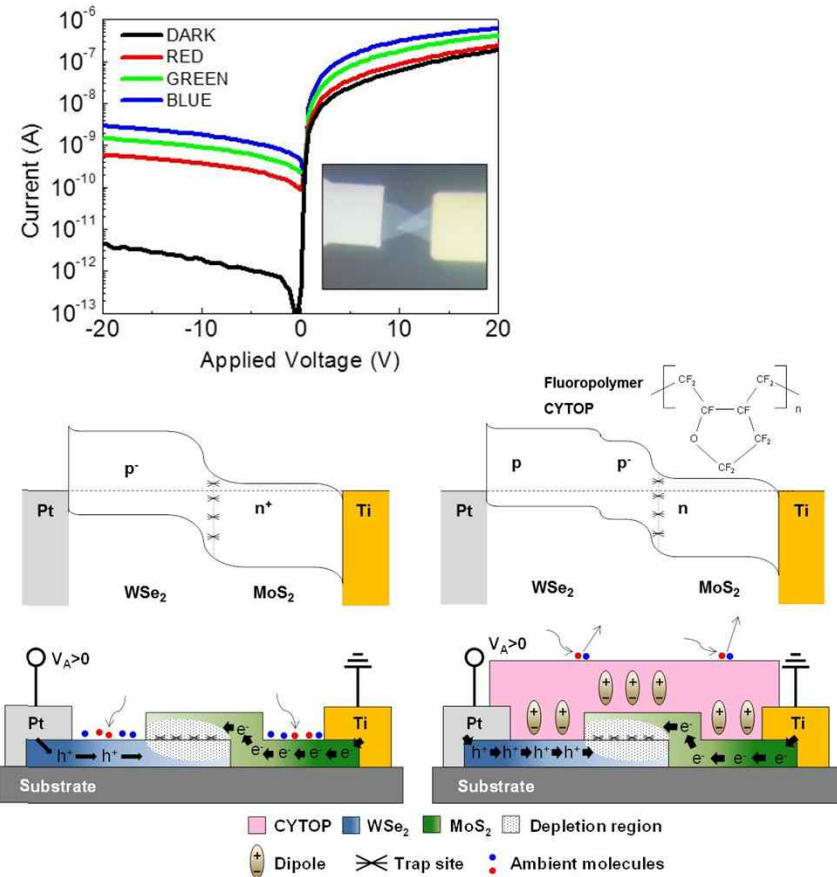
3. Nonvolatile Memory FETs

MoS₂ Nanosheets for Top-Gate Nonvolatile Memory Transistor Channel, *Small* (2012)

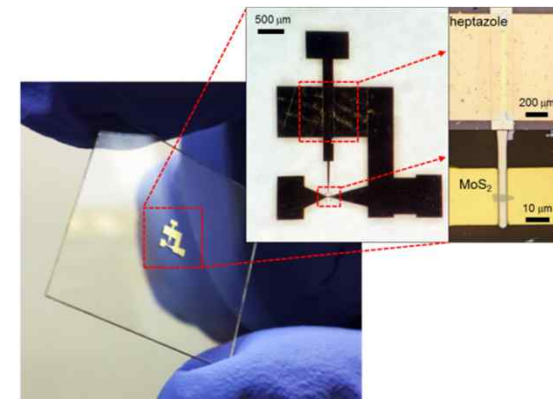
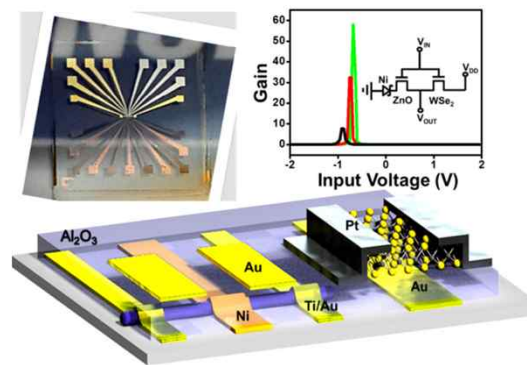
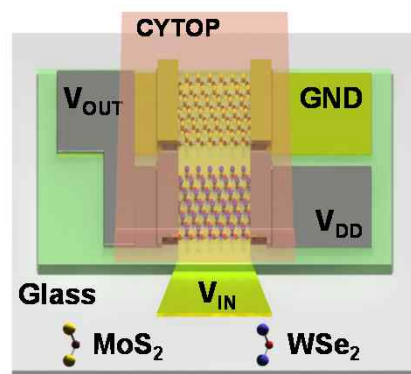


4. 2D-2D van der Waals p-n diode

Enhanced device performance of WSe₂-MoS₂ van der Waals junction p-n diode by fluoropolymer encapsulation, *JMC C* (2015)



2D-2D, 2D-1D, 2D-Organic Hybrid Complementary Inverter



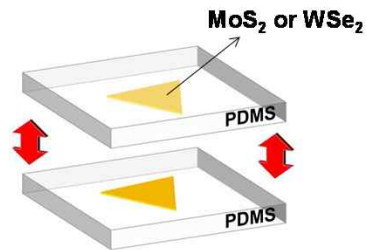
P. J. Jeon et al. *ACS Appl. Mater. Interfaces*, DOI: 10.1021/acsami.5b06027 (2015)

S. H. Hosseini Shokouh et al., *Adv. Mater.* **2015**, *27*, 150 (2015)

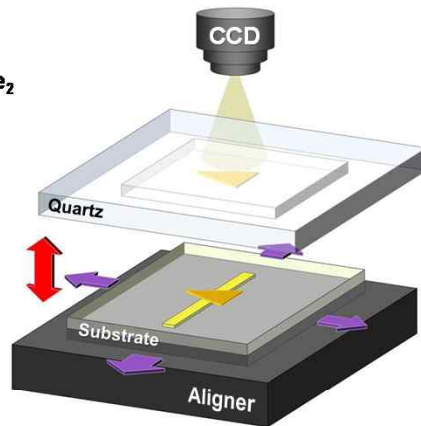
H.S. Lee et al. *Small*, **11**, 2132 (2015)

Fabrication : Direct Imprinting Method

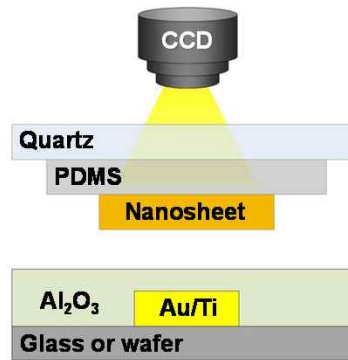
Step1 | Flake exfoliation



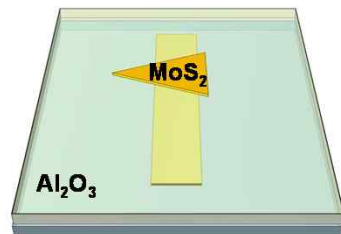
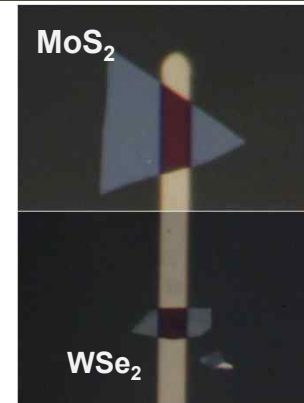
Step2 | Alignment



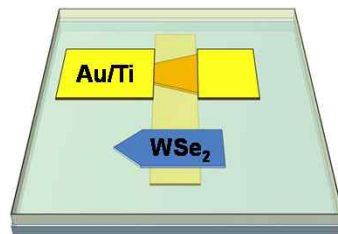
Step3 | Flake imprinting



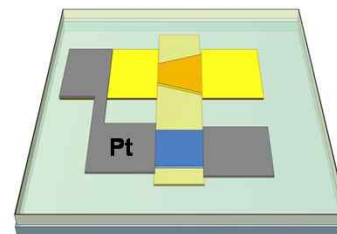
Transferred flakes on patterned-gate



Step4 | MoS₂ transfer

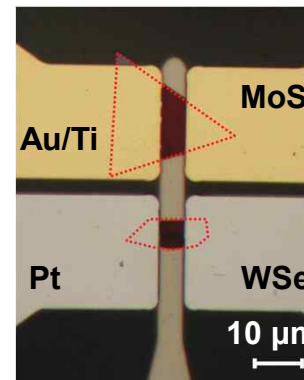


Step5 | WSe₂ transfer



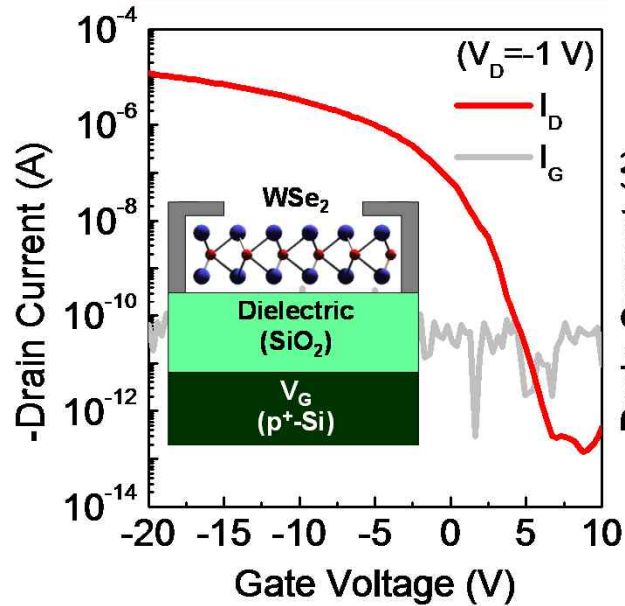
Step6 | SD patterning

Source/Drain patterning

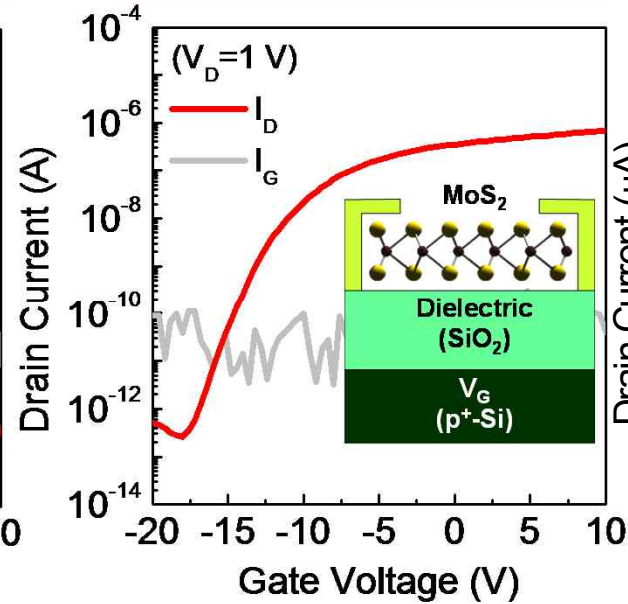


2D p-WSe₂ and n-MoS₂ FETs on Wafer

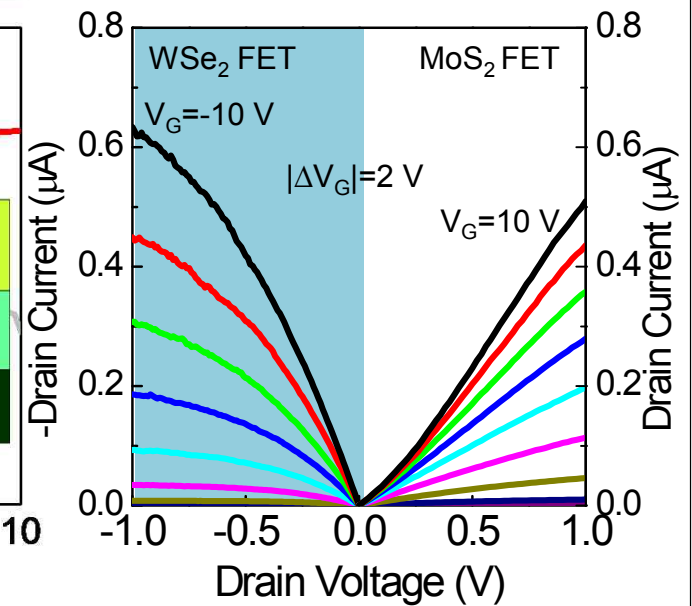
WSe₂ FET Transfer Curve



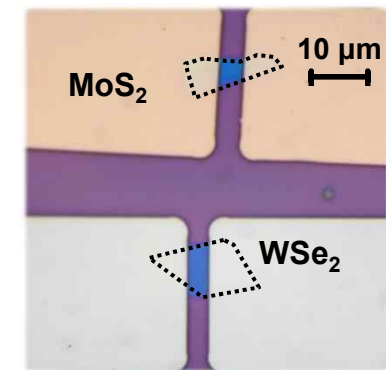
MoS₂ FET Transfer Curve



Output Curves

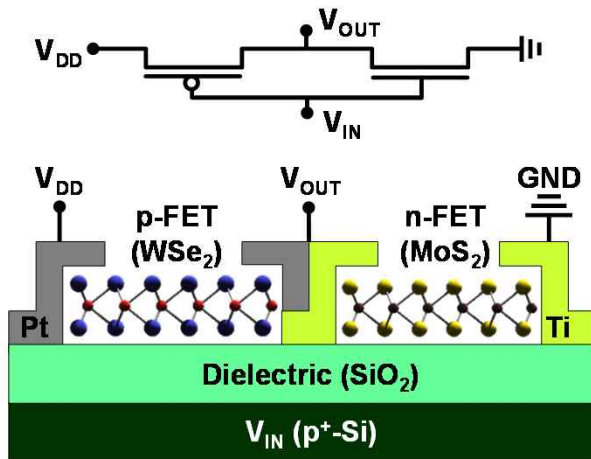


- 285 nm-thick SiO₂/p⁺-Si substrate
- Large operation voltage in a range of $V_G = -20 \sim 10$ V
($V_{TH} = +5$ V for p-WSe₂, $V_{TH} = -15$ V for n-MoS₂)
- Large gate-source leakage current of $I_{GS} \sim 100$ pA
- Large overlap area between un-patterned gate and source/drain electrodes

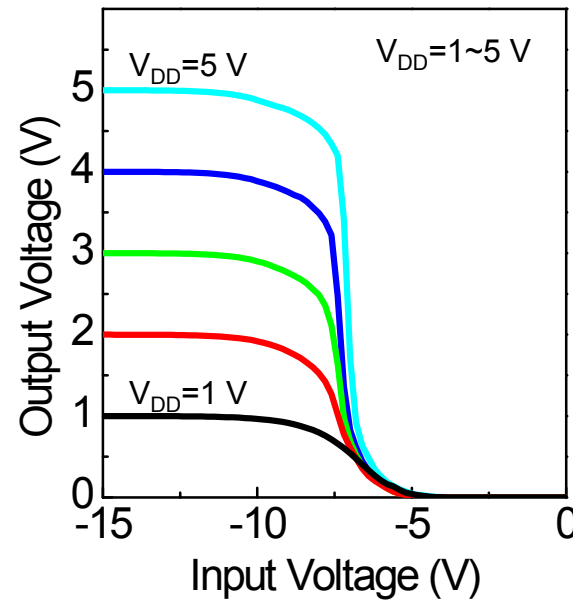


Complementary Inverter on Wafer

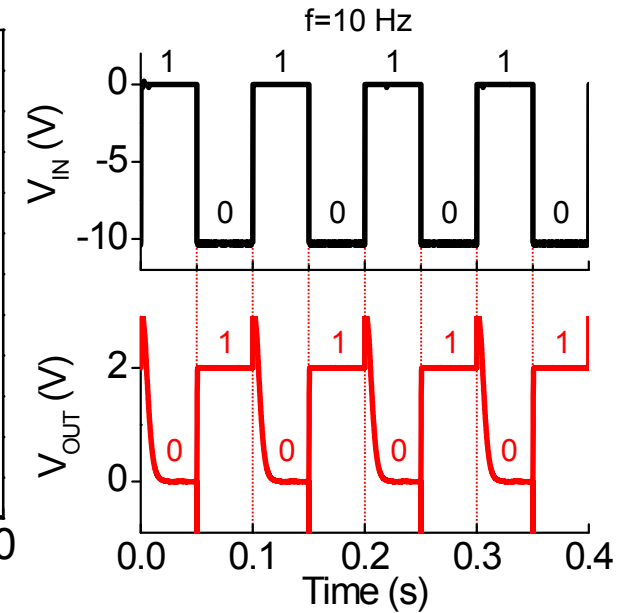
Complementary inverter



VTC

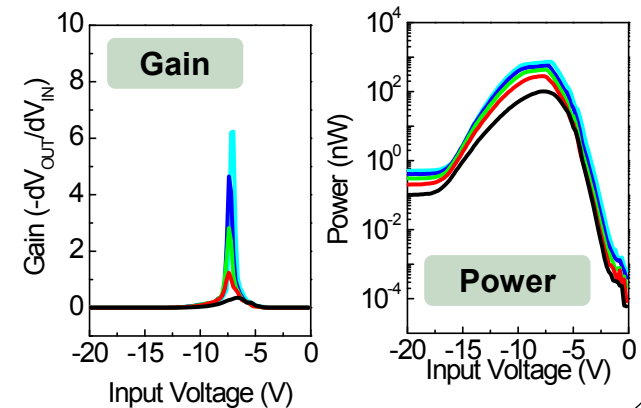


Dynamic switching



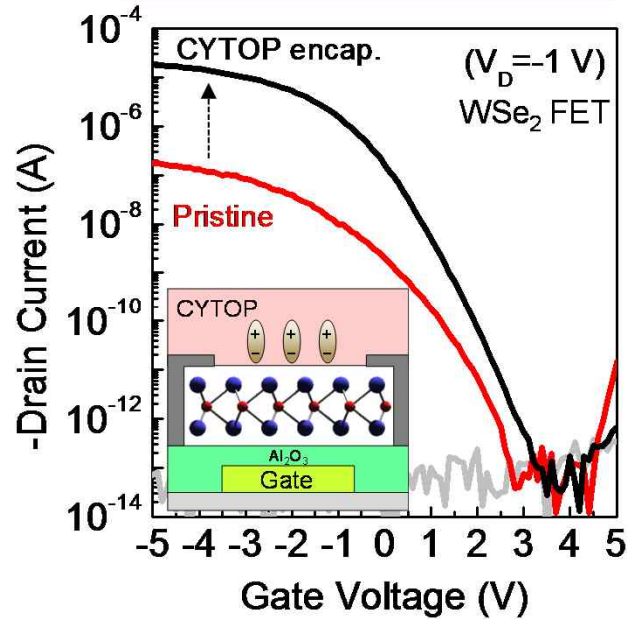
- Negative transition voltage of $V_{TR} = -7.5 \text{ V}$
(not suitable for practical applications)
- Voltage gain ($-dV_{OUT}/dV_{IN}$) : ~ 6
- Peak power consumption ($P = V_{DD} \times I_{DD}$) : $\sim 1 \mu\text{W}$
- Large switching delay of 10 ms

due to overlap capacitance-induced booster effects

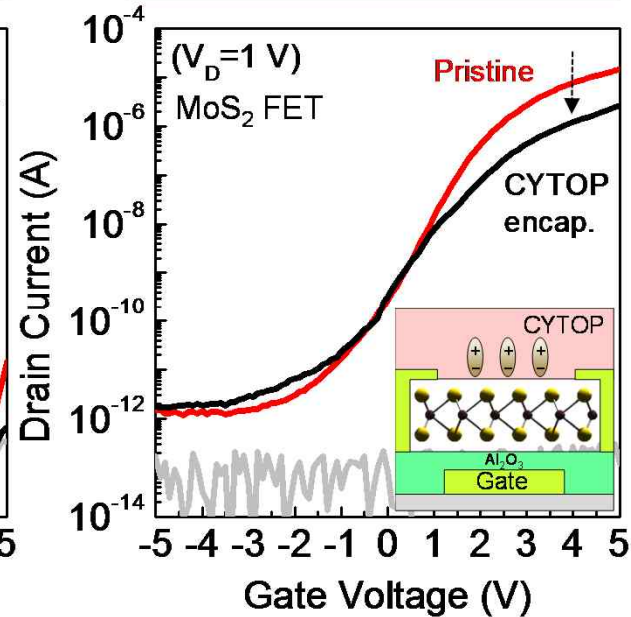


2D p-WSe₂ and n-MoS₂ FETs on Glass

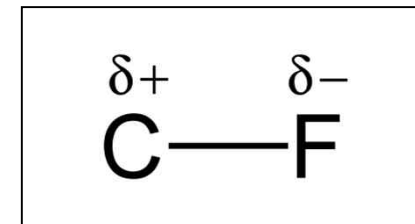
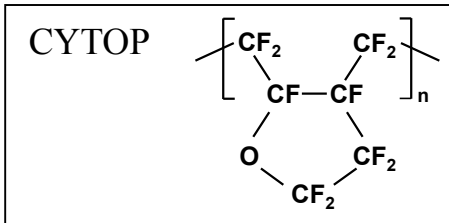
WSe₂ FET Transfer Curve



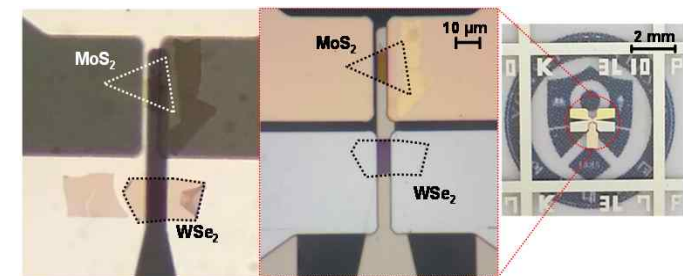
MoS₂ FET Transfer Curve



Fluoropolymer CYTOP

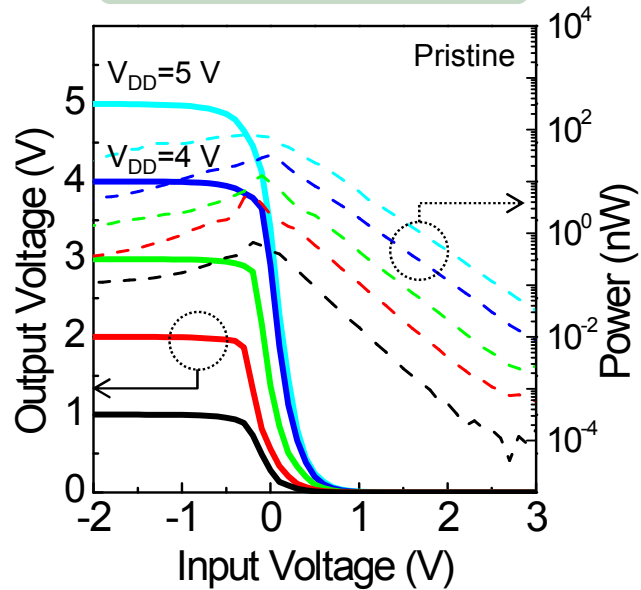


- 50 nm-thin Al₂O₃ (ALD)/**Patterned gate** on **glass** substrate
- : Low operation voltage of $V_G = -5 \sim +5$ V
- : Low gate-source leakage current of <100 fA
- Fluoropolymer CYTOP encapsulation (**C-F bond-induced dipoles**)
- : **Induced** more **hole carriers** into thin p-WSe₂ (positive V_{TH} shift)
- : **Reduced electrons** in thin n-MoS₂ (reduced on-current).

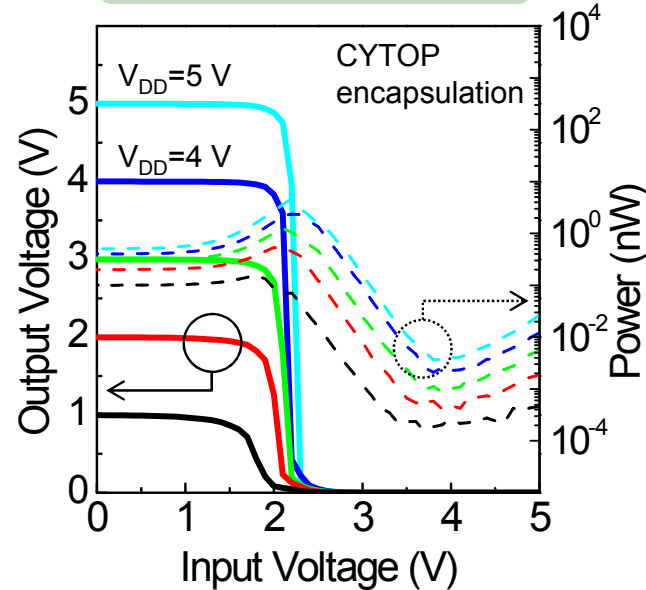


Complementary Inverter on Glass

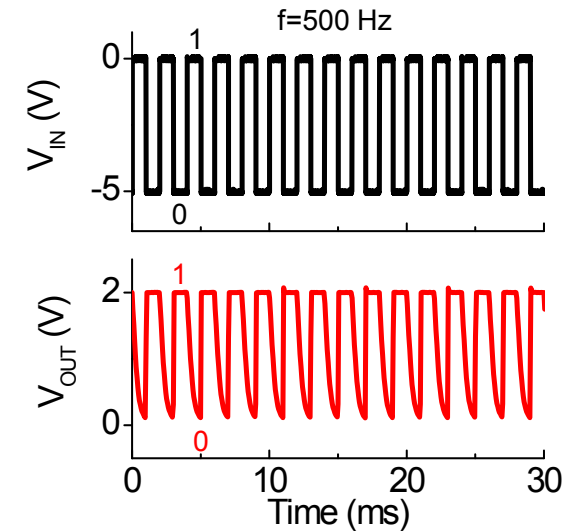
VTC before CYTOP



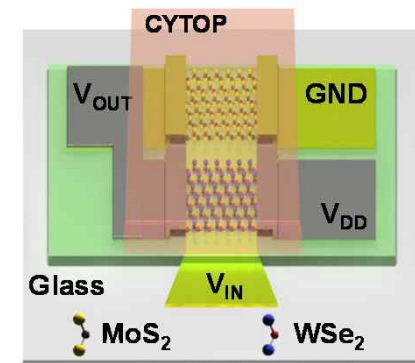
VTC after CYTOP



Dynamic Switching

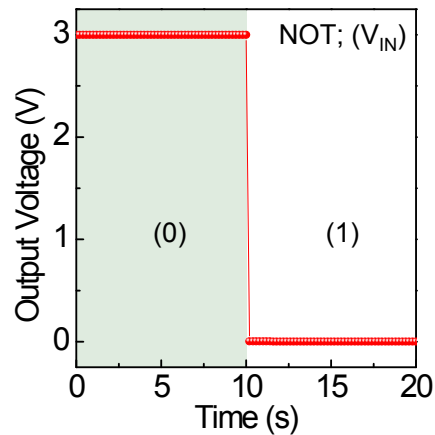
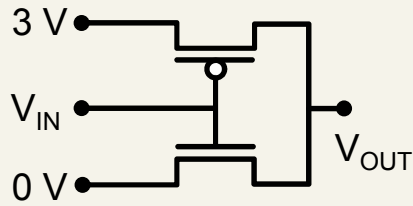


- **Positive transition voltage shift** after CYTOP encapsulation (V_{TR} ; 0.1 V \rightarrow 2.3 V)
- High **voltage gain of 23** at $V_{DD}=5\text{ V}$
- Subnanowatt power consumption : $P_{peak} \sim 1\text{ nW}$
- Ideal noise margin ($NM_L=0.385 \times V_{DD}$, $NM_H=0.495 \times V_{DD}$ at $V_{DD}=5\text{ V}$)
- Switching delay : $\sim 800\text{ }\mu\text{s}$



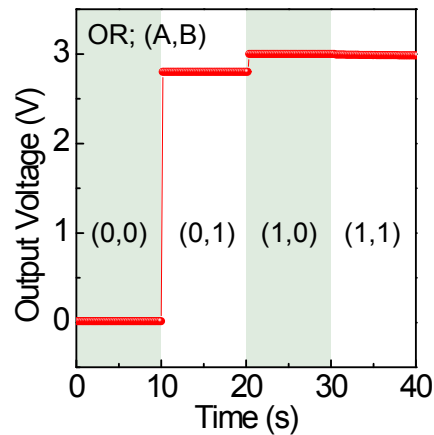
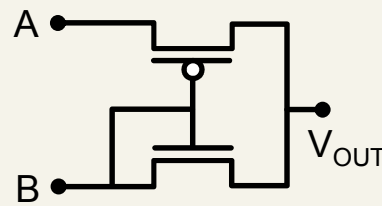
Pass Transistor Logic Gates

NOT gate



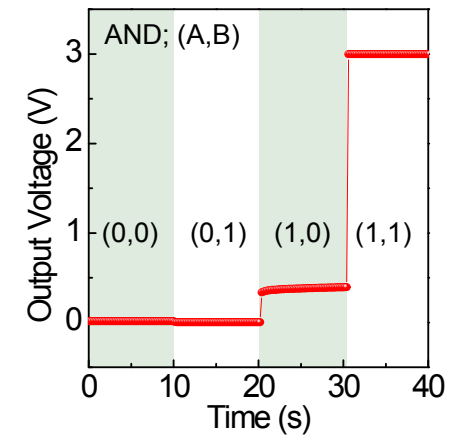
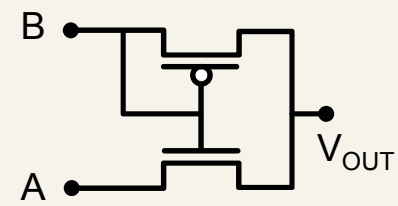
V_{IN}	V_{OUT}
0	1
1	0

OR gate



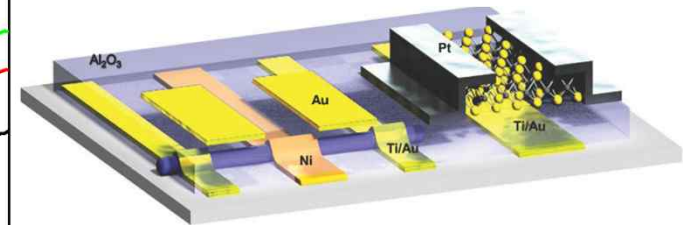
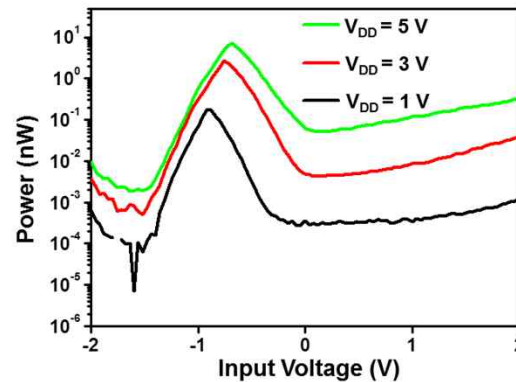
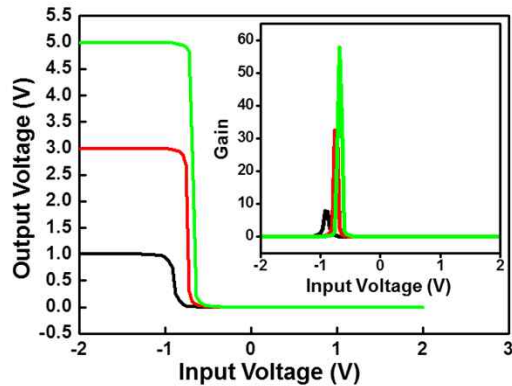
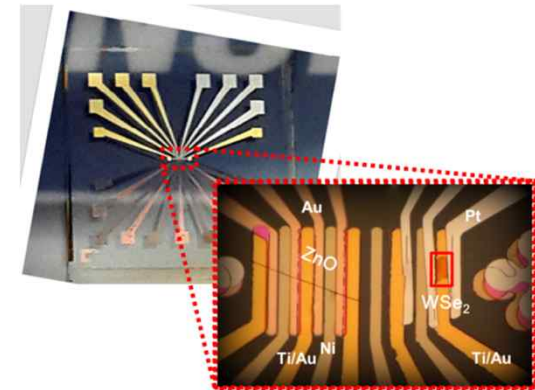
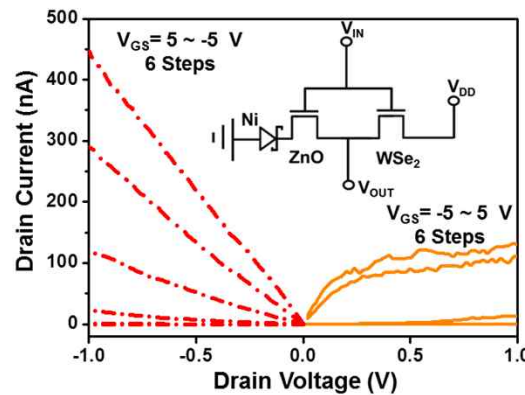
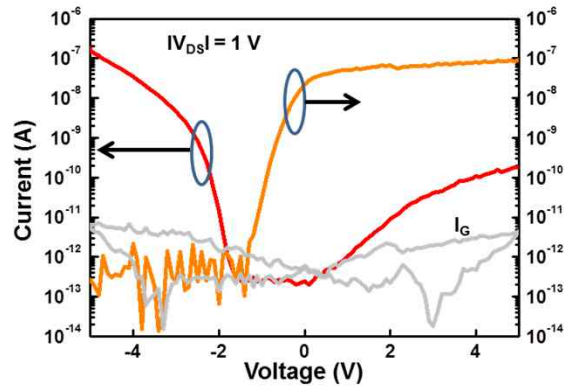
A	B	$V_{OUT}=A+B$
0	0	0
0	1	1
1	0	1
1	1	1

AND gate



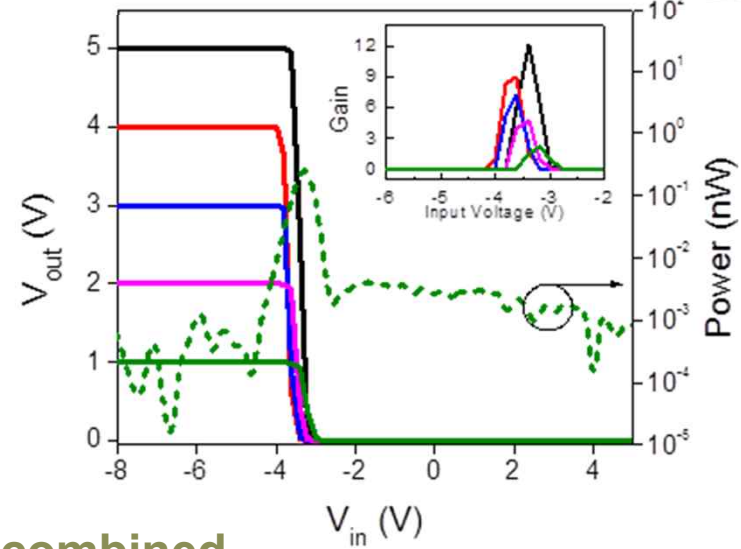
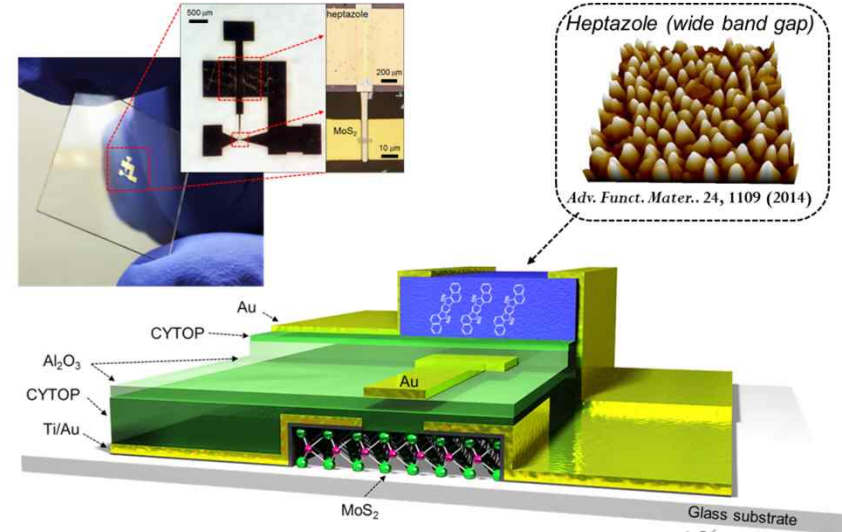
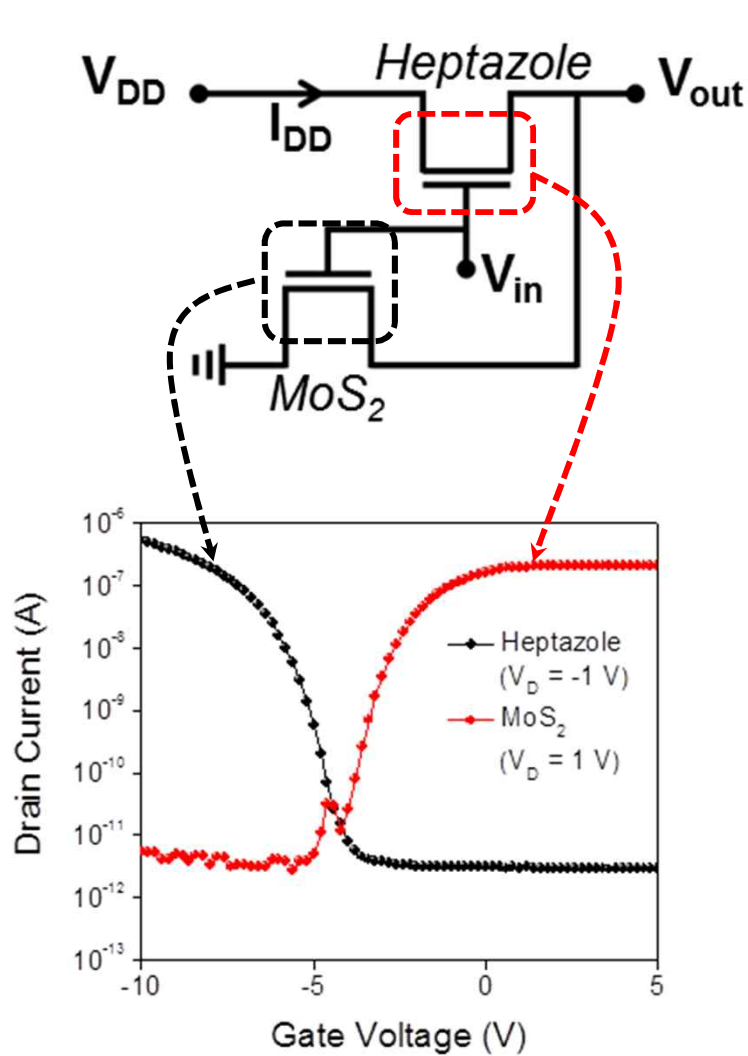
A	B	$V_{OUT}=AxB$
0	0	0
0	1	0
1	0	0
1	1	1

2D-1D Hybrid Complementary Inverter



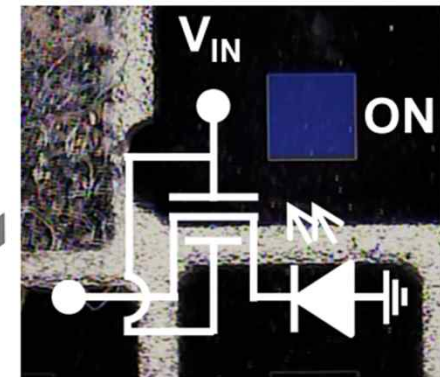
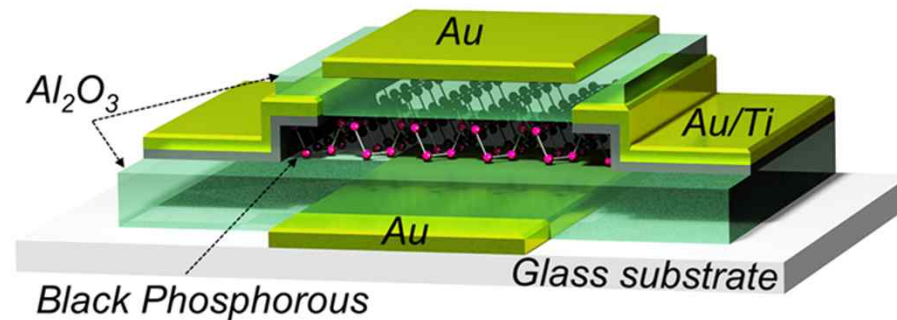
Voltage gain of 60 and subnanowatt power consumption at static states
 ↪ Highest gain and lowest power consumption for reported 2D material based inverter

2D-Organic Hybrid Complementary Inverter



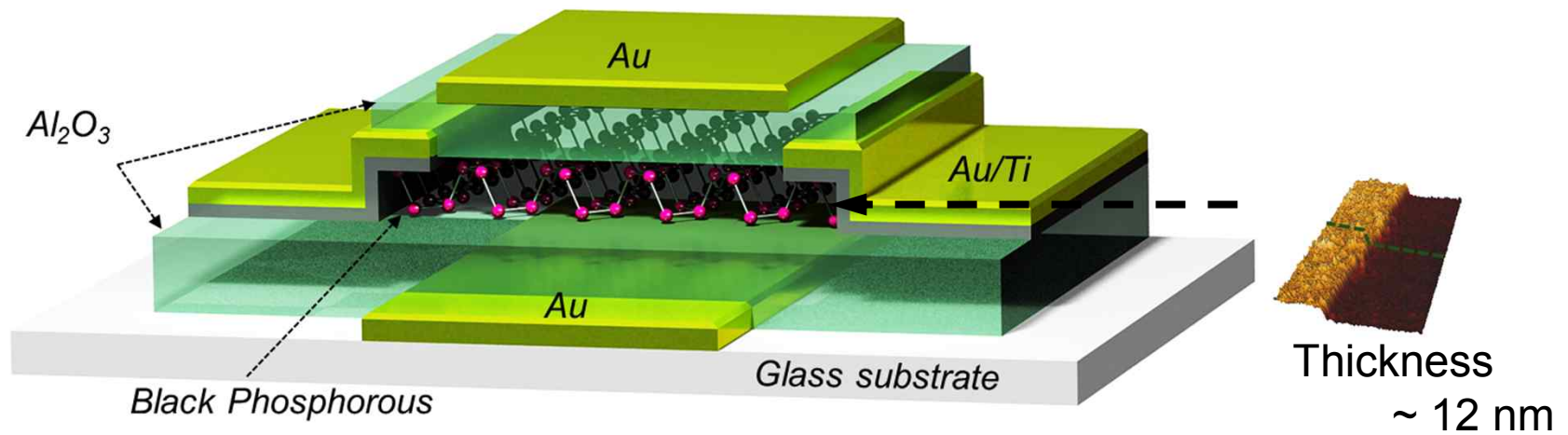
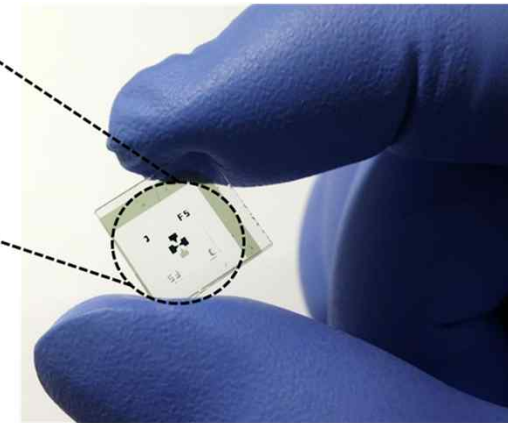
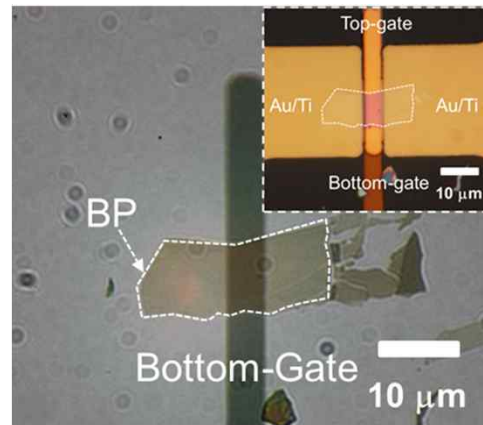
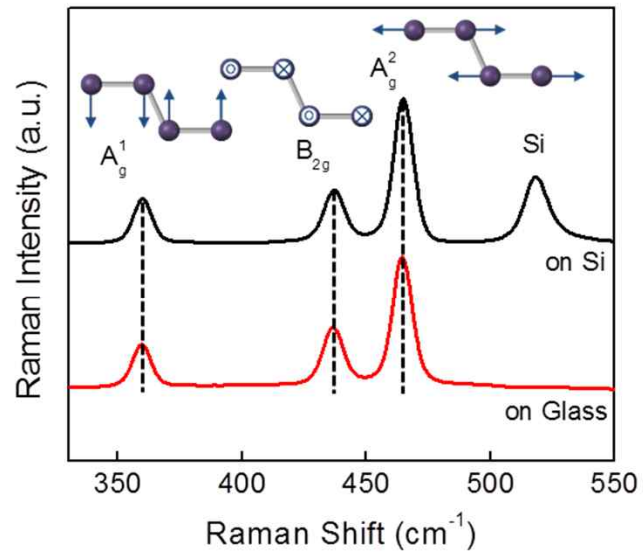
Forecast some possibility to use 2D FET combined with Org. Elec. ?

Dual gate black phosphorous field effect transistors on glass for NOR logic and organic light emitting diode switching

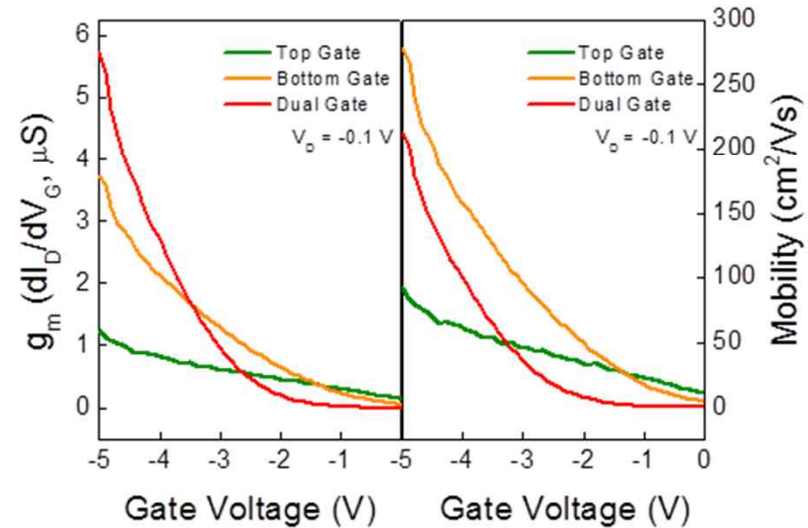
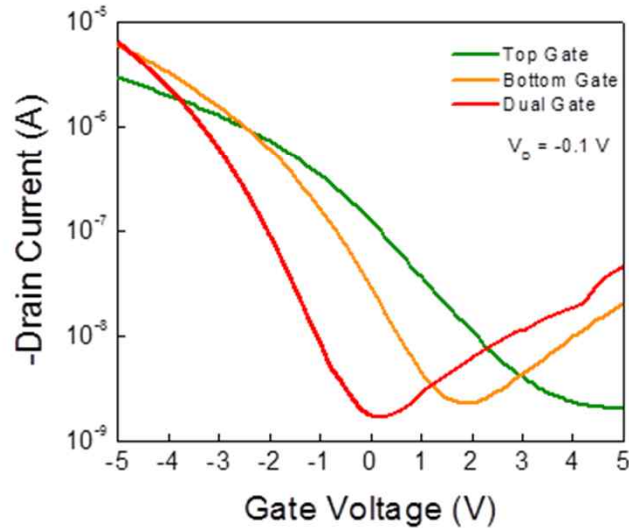
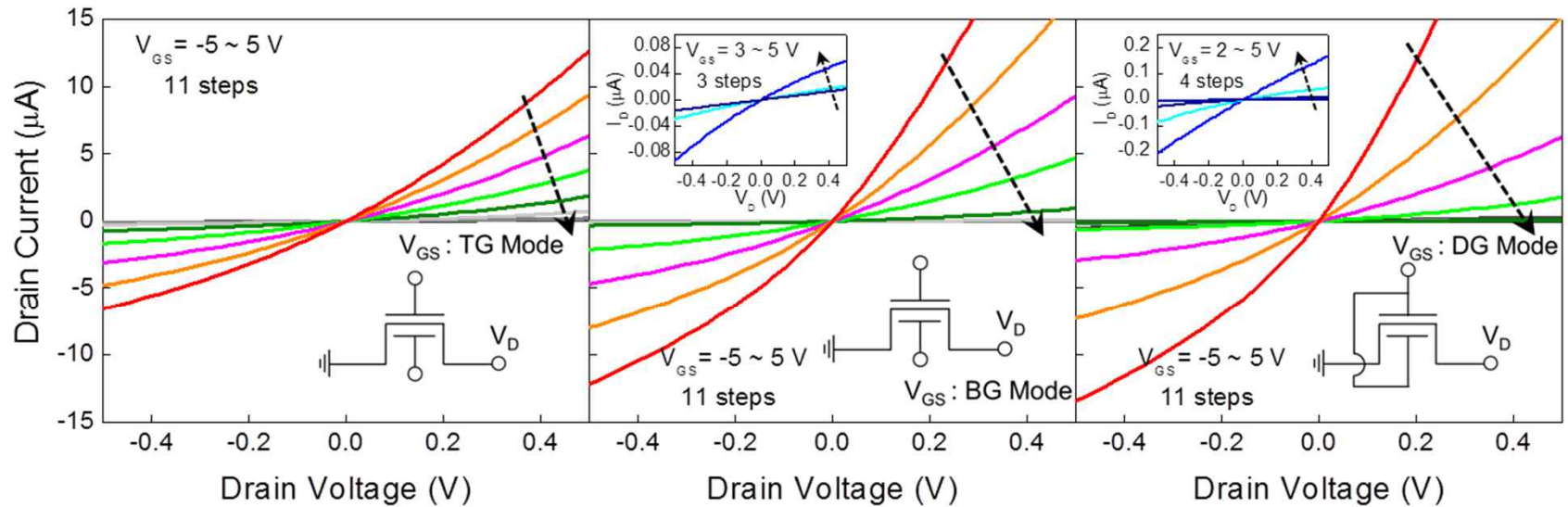


J. S. Kim et al. *Nanoletters*, **15**, 5778, (2015)

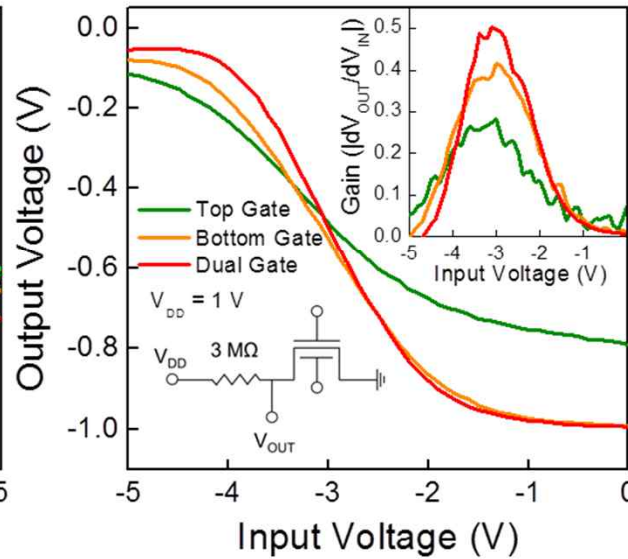
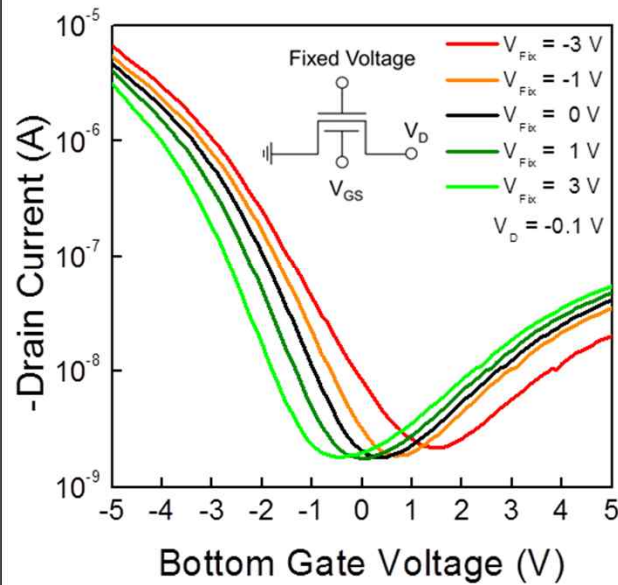
Images and Raman spectra



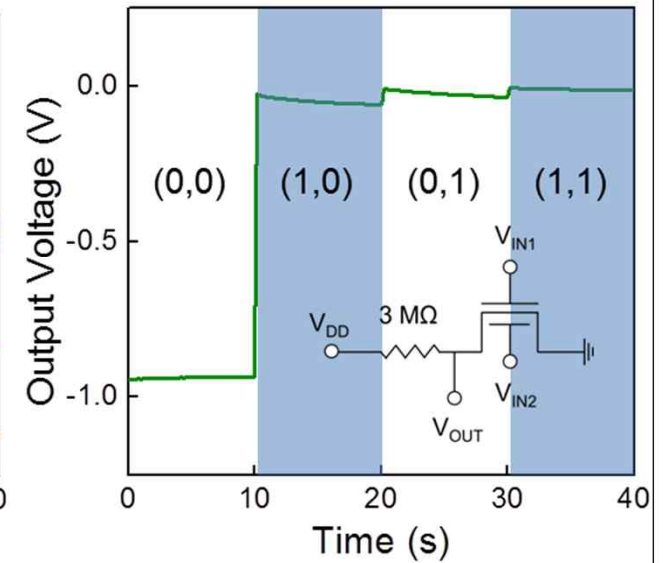
I-V Characteristics of Dual gate FET



Voltage shifts & Logic gate



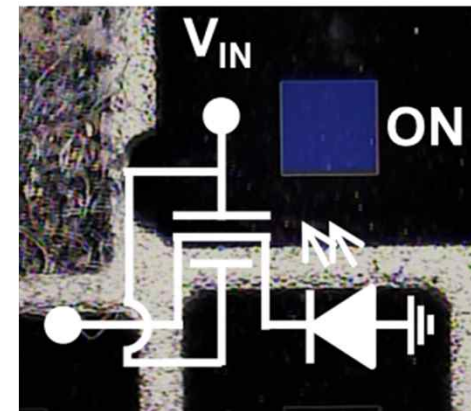
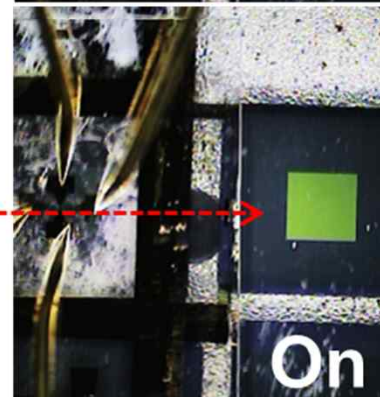
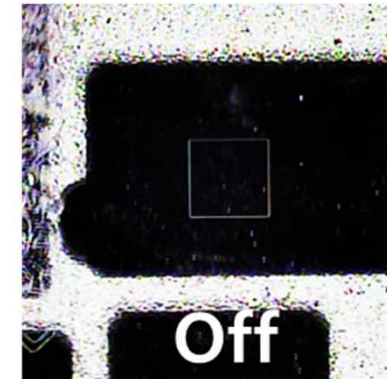
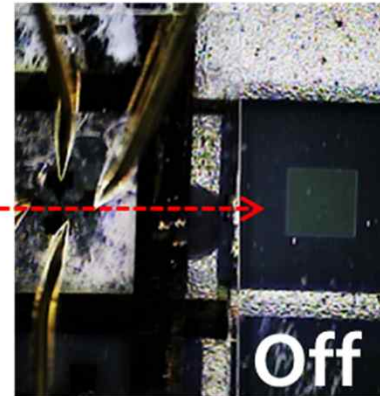
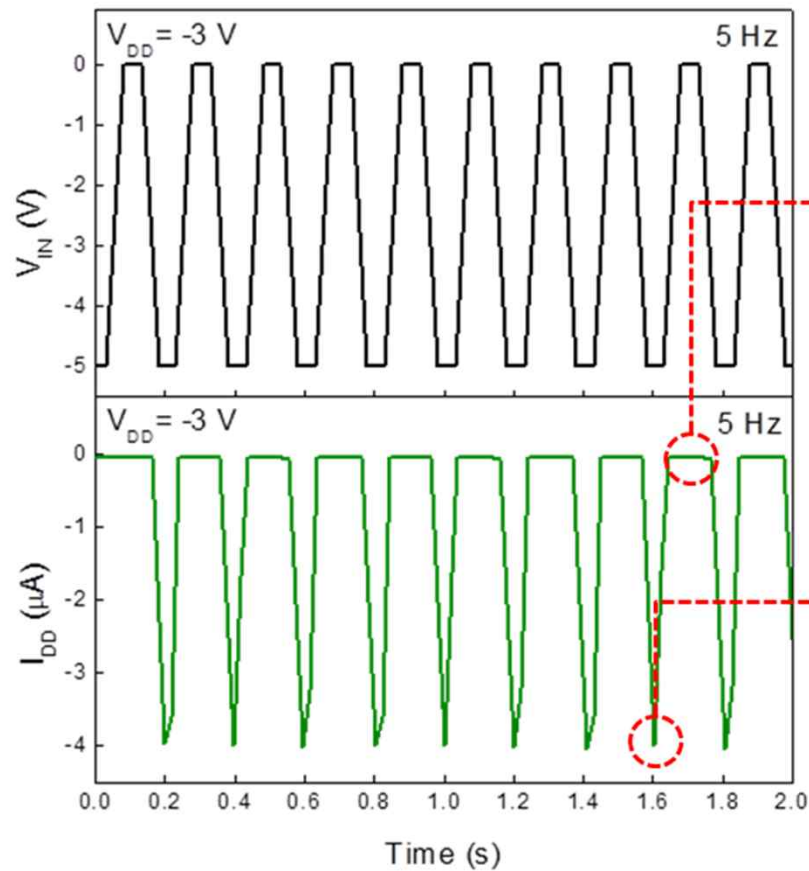
NOT logic



NOR logic

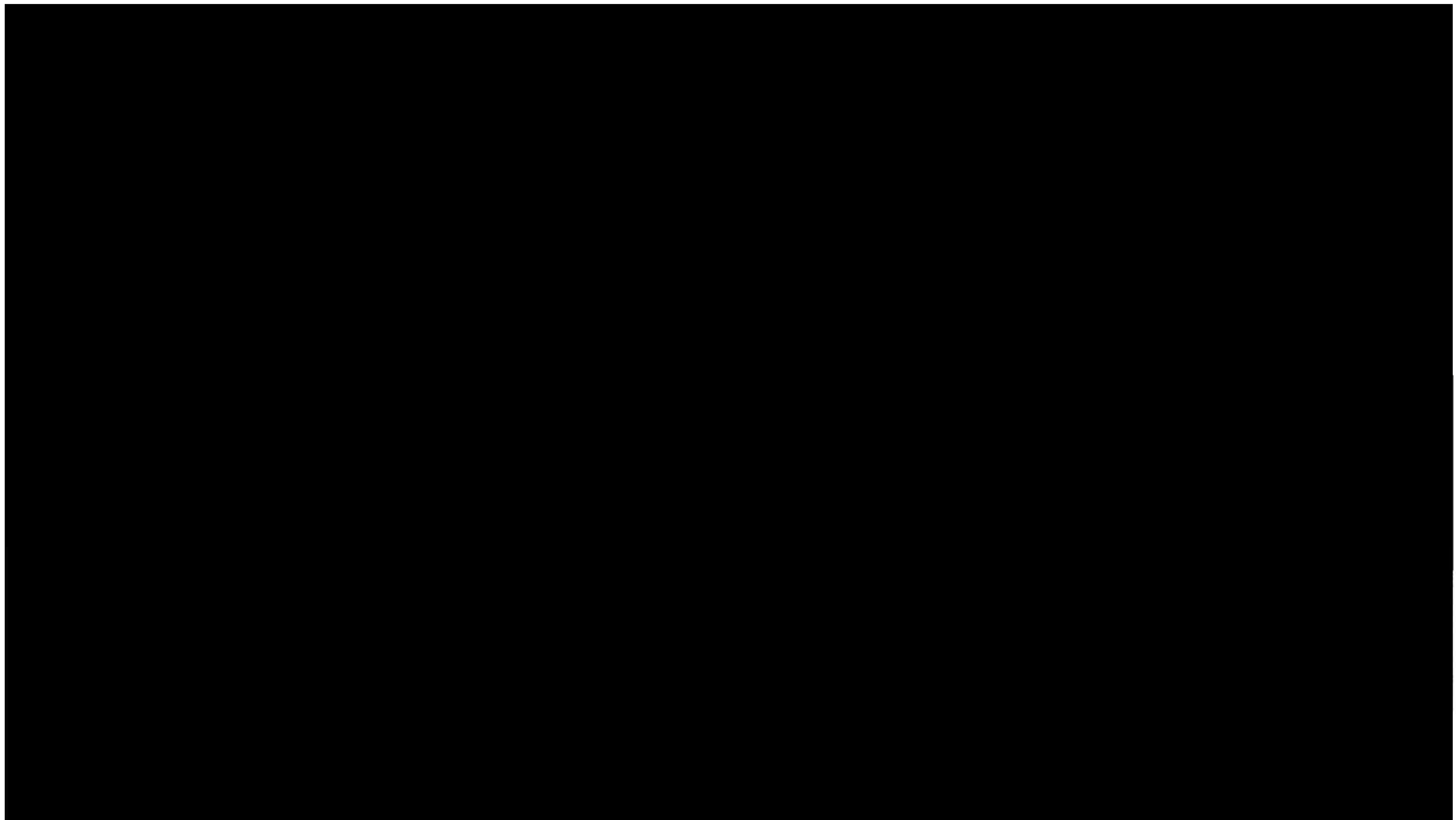
ambipolar transition voltage shifts from -0.5 to 1.5 V by applied top gate bias

Dynamic OLED Switching



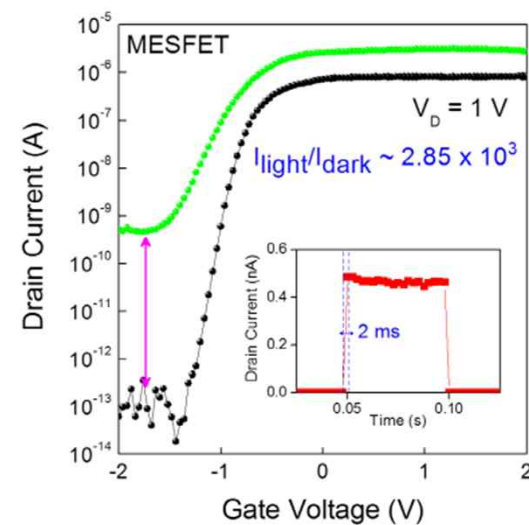
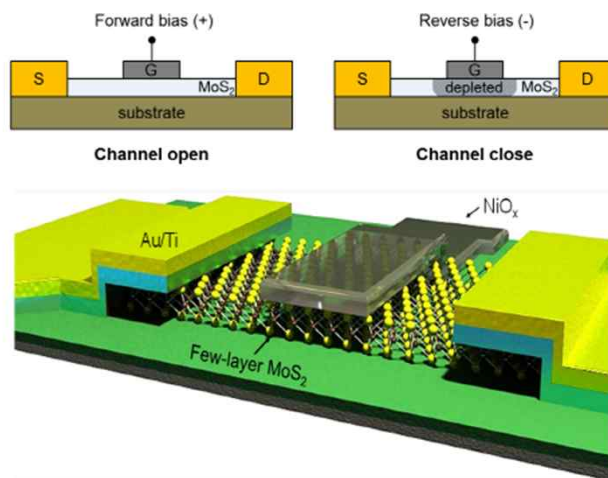
Well switching operated as Green, blue OLED pixel

Dynamic OLED Switching



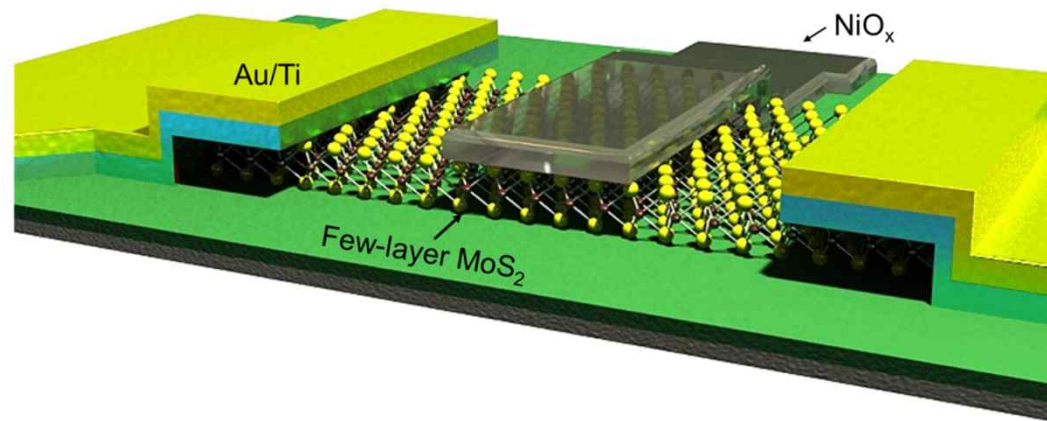
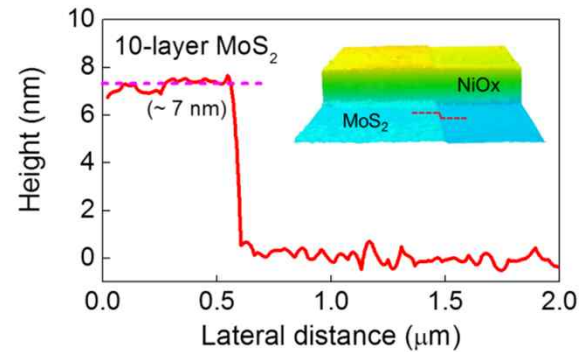
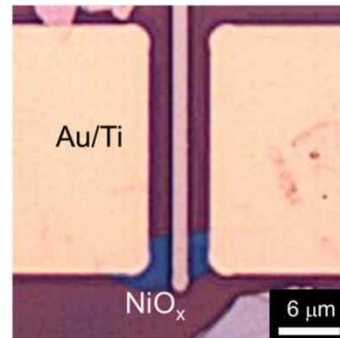
well switching operated as Green, blue OLED pixel

NiO_x-MoS₂ metal-semiconductor field-effect transistor for high mobility and photoswitching speed



H.S. Lee et al. *ACS Nano*, **9**, 8312, (2015)

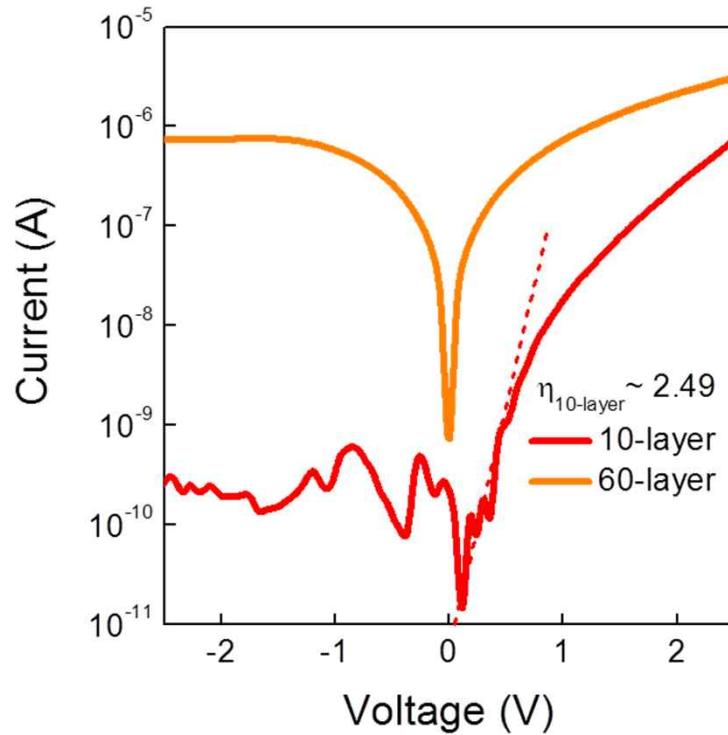
Structure of MoS₂ MESFET



“Thermally evaporated **NiO_x** is known to have quite a **deep work function** of more than 5.1~5.2 eV as a Ni-rich **semi-transparent conducting oxide** (x~0.9).”

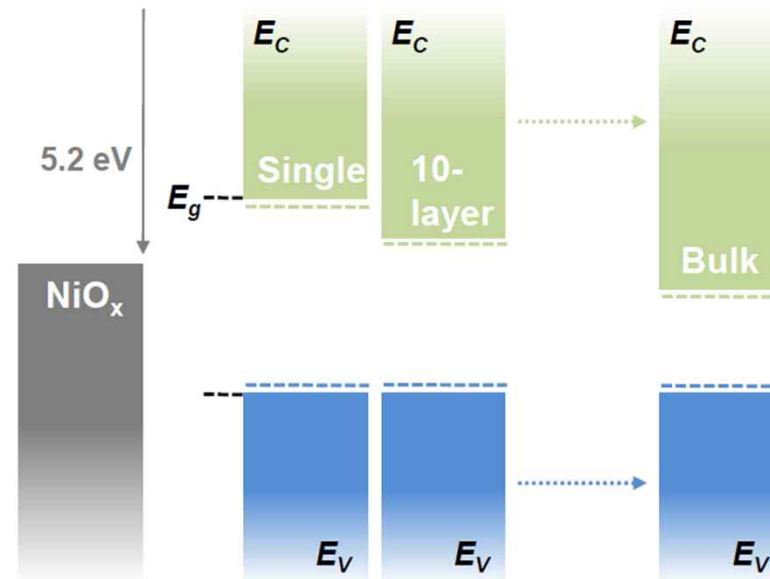
NiO_x van der Waals Schottky Interface

Schottky diode IV curves



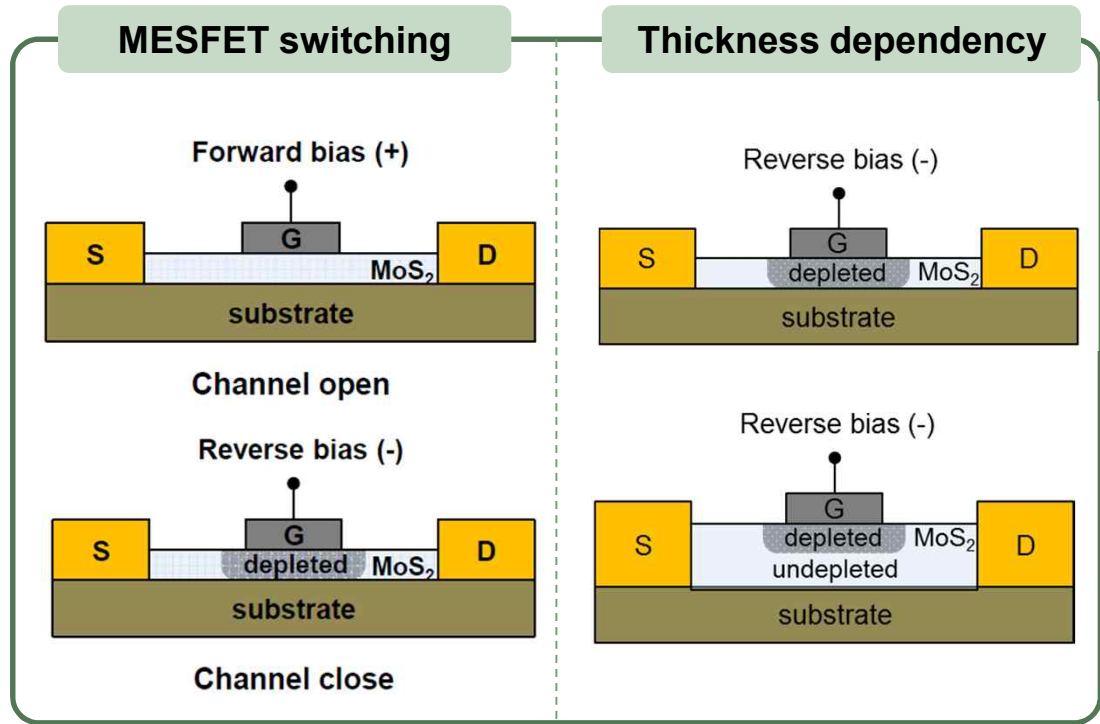
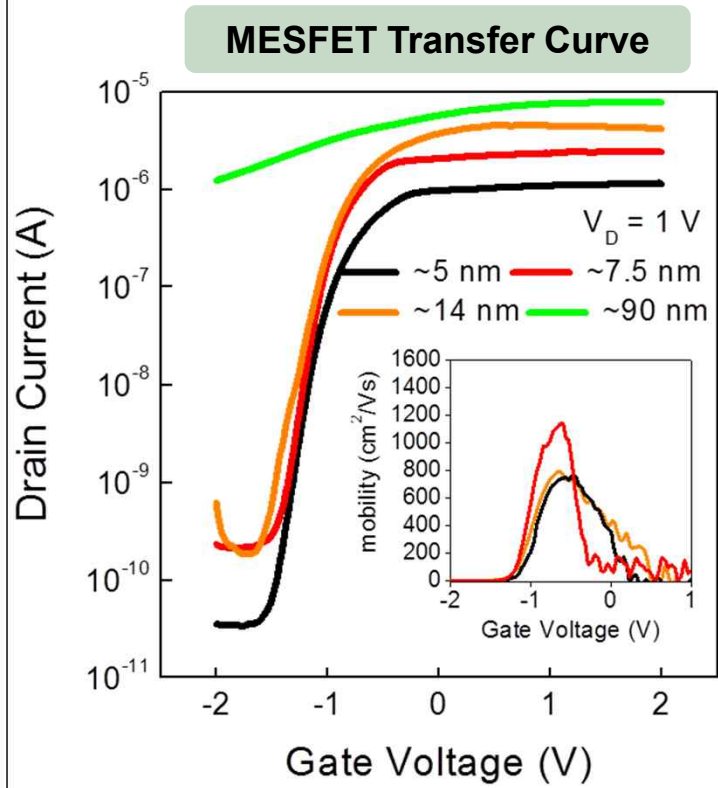
- The better rectifying behavior for the thinner MoS₂

Energy band diagram



- The higher Schottky barrier height for the thinner MoS₂
- $q\phi_B = q\phi_{NiOx} - qX_{MoS2}$

MESFET : Channel Thickness Effects



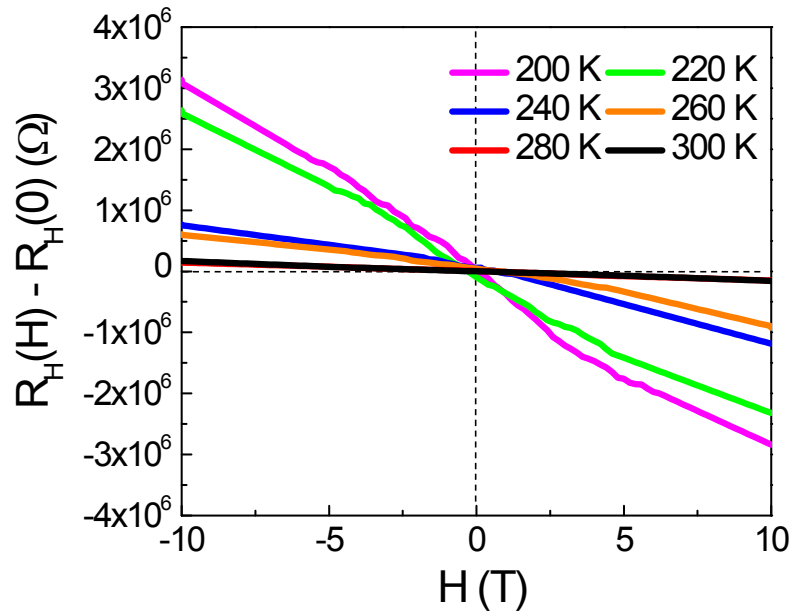
- NiO_x/MoS₂ van der Waals interface: 0.3 nm gap by calc. !

**MESFET
Mobility**

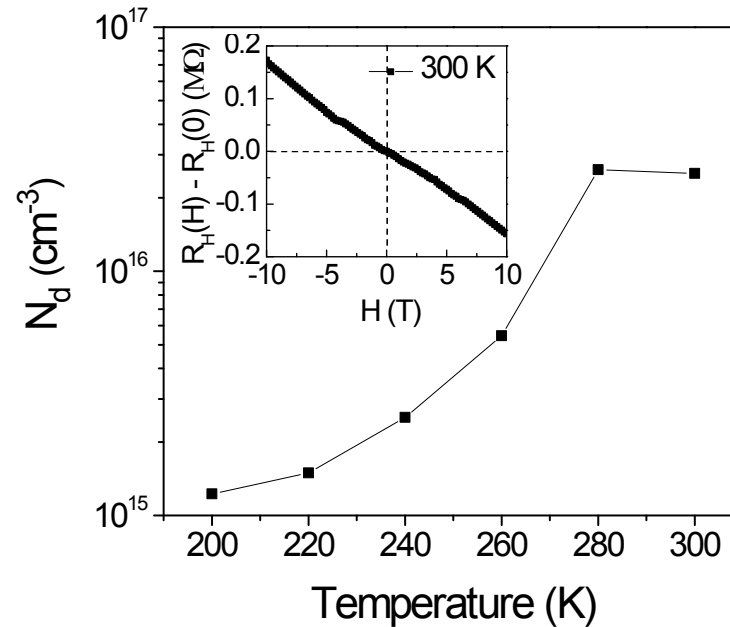
$$\mu = \frac{Lg_{\text{Max}}}{qN_d t W}, \text{ where } g_m = \frac{\partial I_D}{\partial V_G} = \frac{qN_d \mu t W}{L}$$

4-Probe Hall Measurement

MoS₂ Hall Coeff-H(T) Curve



MoS₂ Nd conc. (T) plot

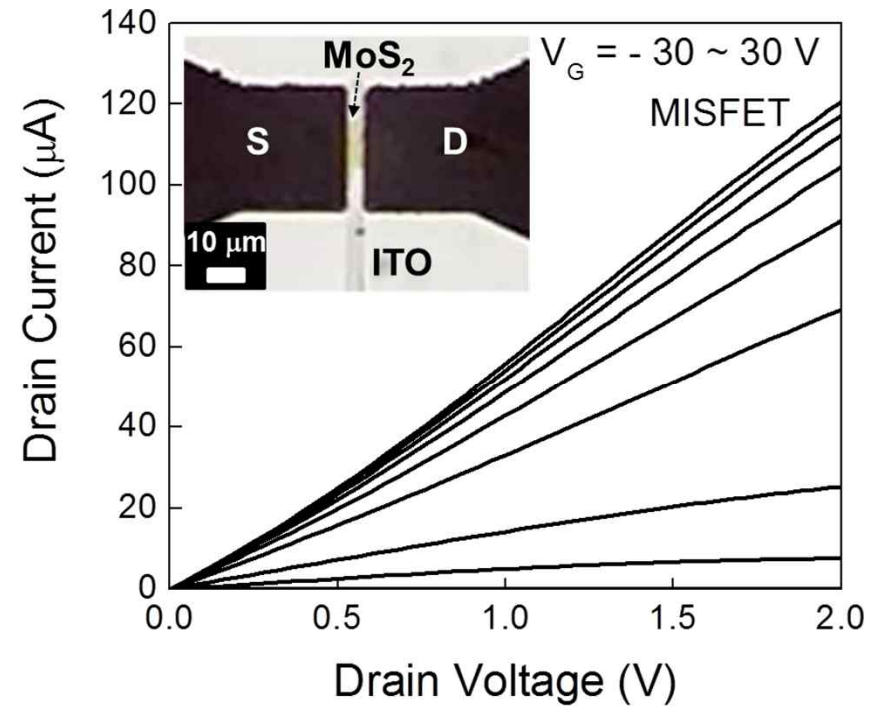
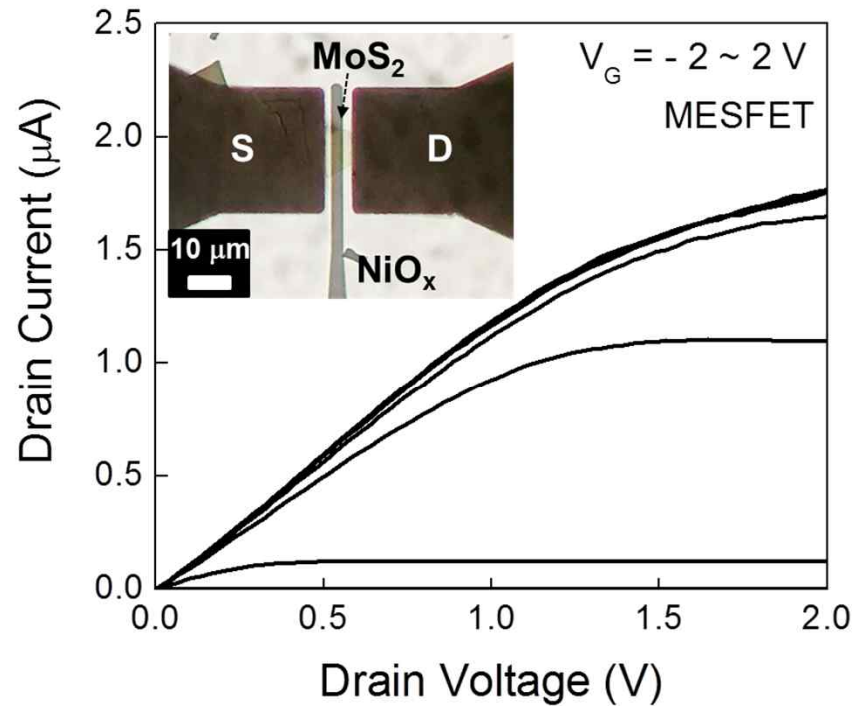


$$R_H = \frac{V_H}{I} = -\frac{H}{n_s q} \rightarrow n_s = -\frac{1}{q} \left(\frac{\partial R_H}{\partial H} \right)^{-1}$$

- $n_s = 4.03 \times 10^{10} \text{ cm}^{-2}$ (**$2.52 \times 10^{16} \text{ cm}^{-3}$**)
for 16 nm-thick MoS₂ at 300 K
- Hall mobility of 16 nm-thick MoS₂ : $\sim 200 \text{ cm}^2/\text{V s}$



MESFET vs. MISFET

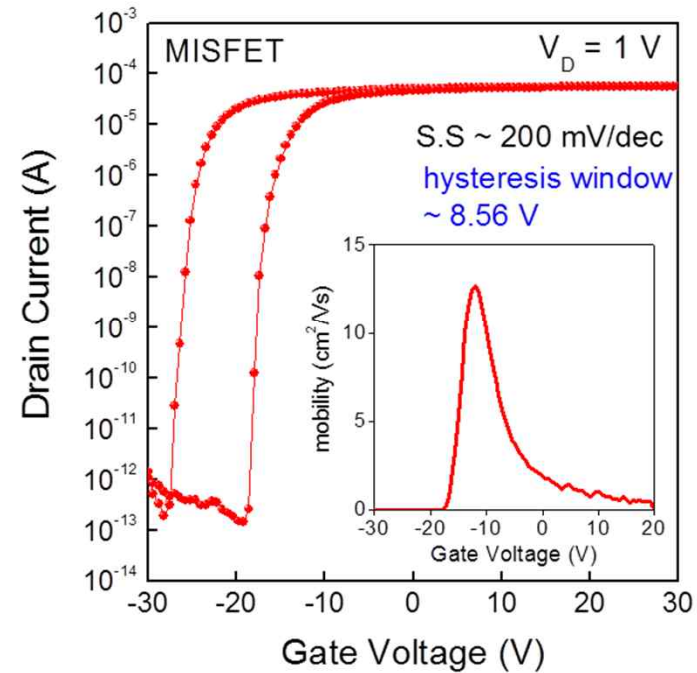
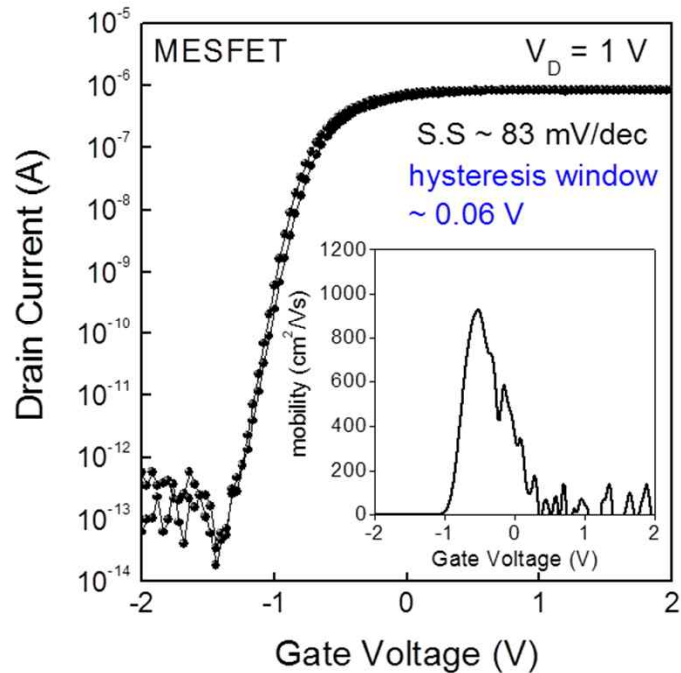


Saturation behavior in MESFET

: easier channel-depletion (pinch-off) in drain side

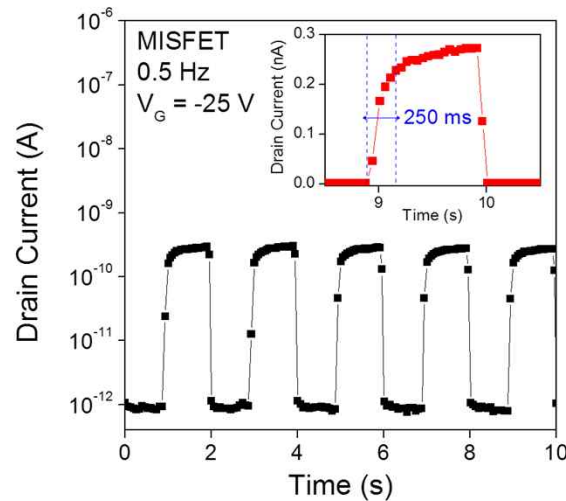
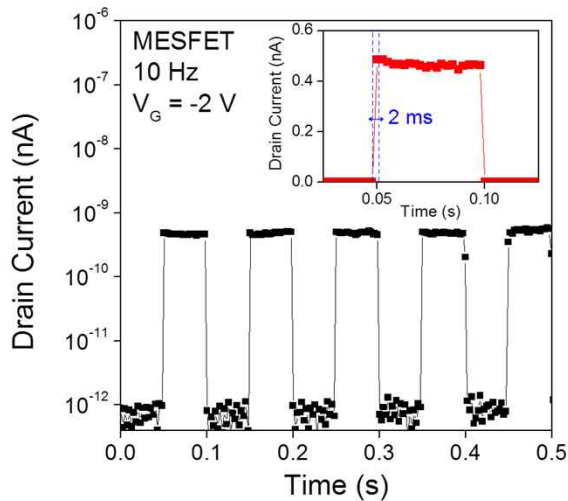
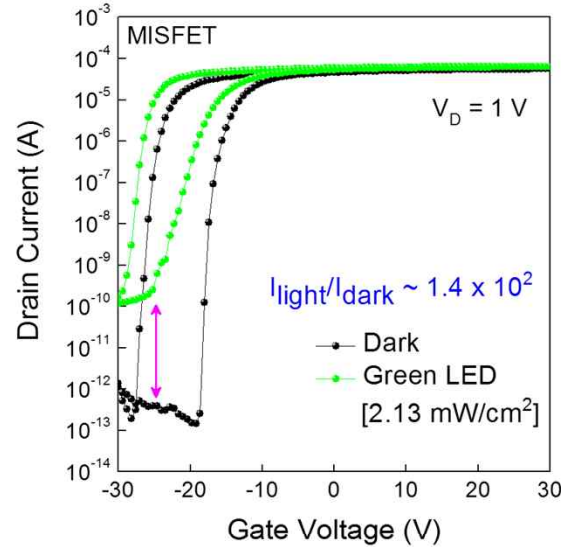
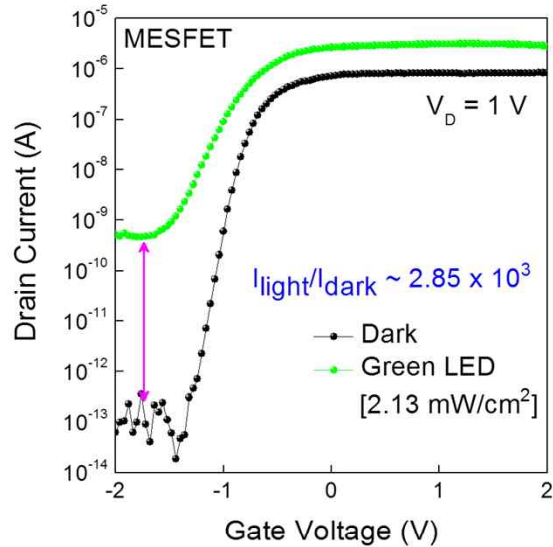
MESFET vs. MISFET

“The carrier transport in MESFET may hardly be interfered by insulator-semiconductor **interface traps** or an **on-state gate field**.”



Parameters	MESFET	MISFET
Subthreshold swing	83 mV/dec	200 mV/dec
Mobility	950 $\text{cm}^2/\text{V s}$	13 $\text{cm}^2/\text{V s}$
Hysteresis	0.06 V	8.56 V
Threshold voltage	-1 V	-25 V

Photo-detecting properties & Dynamic



	MESFET	MISFET
Photo-to-dark current ratio	2.85×10^3	1.4×10^2
Responsivity (ON state)	5000 A/W	
Responsivity (OFF state)	1.1 A/W	
Delay	2 ms	250 ms

Summary

- **2D-FETs**

analysis MoS₂ band gap, nonvolatile memory, p-n diode

- **Hybrid complimentary Inverter: nW power, high gain**

2D-2D, 2D-1D, 2D-Organic

- **Black Phosphorous Dual Gate FETs: High current, NOR gate**

TG BG bipolar transition voltage shifts, OLED switching

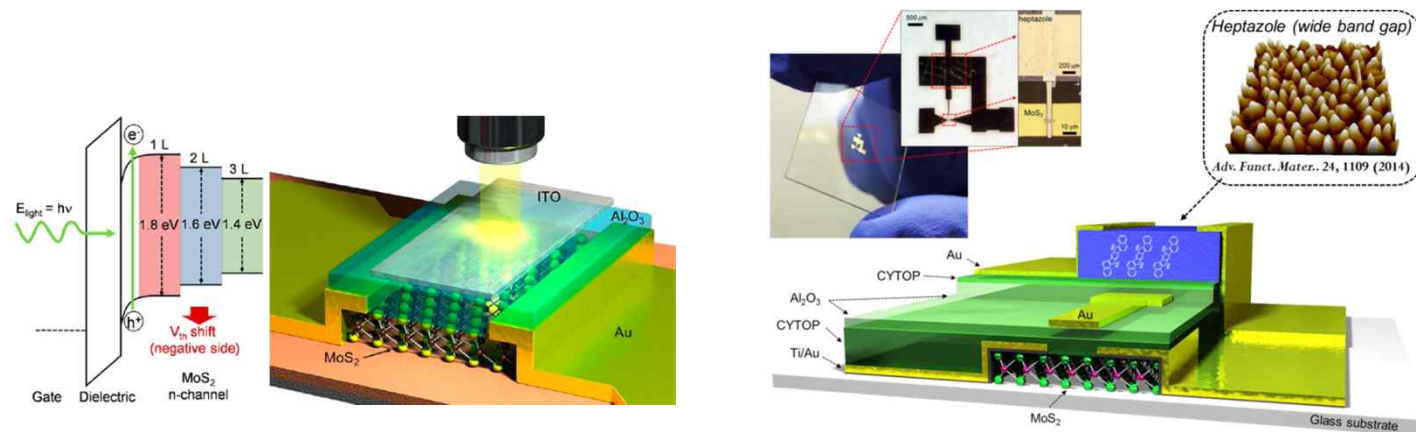
- **NiOx-MoS₂ van der Waals junction MESFET:**

Intrinsic high mobility and photo-switching speed

IM's group activity on 2D Devices

FET

1. MoS₂ nanosheet phototransistors with thickness-modulated optical energy gap, *Nano Letters*, **12**, 3695 (2012)
2. MoS₂ nanosheets for top-gate nonvolatile memory transistor channel, *Small*, **20**, 3111 (2012)
3. Nanosheet thickness-modulated MoS₂ dielectric property evidenced by field-effect transistor performance, *Nanoscale*, **5**, 548 (2013)
4. Direct imprint of MoS₂ flakes on the patterned gate for nanosheet transistors, *Journal of Materials Chemistry C*, **1**, 7803, (2013)
5. Graphene versus ohmic metal as source-drain electrode for MoS₂ nanosheet transistor channel, *Small*, **10**, 2356, (2014)
6. Trap density probing on top-gate MoS₂ nanosheet field-effect transistors by photo-excited charge collection spectroscopy
Nanoscale, **7**, 5617 (2015)
7. Metal Semiconductor Field-Effect Transistor with MoS₂/Conducting NiOx van der Waals Schottky Interface for Intrinsic High Mobility and Photoswitching Speed, *ACS Nano*, **9**, 8312, (2015)
8. Dual Gate Black Phosphorus Field Effect Transistors on Glass for NOR Logic and Organic Light Emitting Diode Switching,
Nano letters, **15**, 5778, (2015)
9. High Performance Air Stable Top-gate p-channel WSe₂ Field Effect Transistor with Fluoropolymer Buffer Layer,
Adv. Funct. Mater., DOI: 10.1002/adfm.201502008, (2015)



Im's group activity toward 2D semi.

Hybrid (Complimentary) Inverter

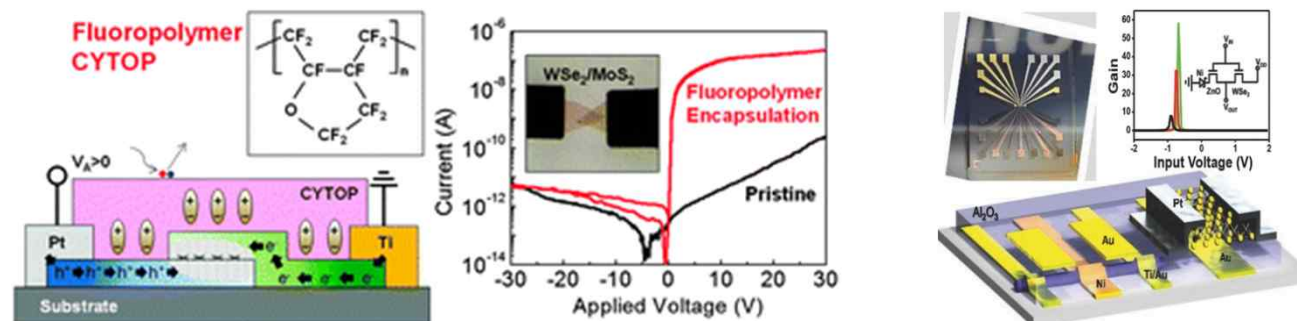
10. Molybdenum disulfide nanoflake-zinc oxide nanowire hybrid photoinverter, **ACS Nano**, **8**, 5174 (2014)
11. Top and back gate molybdenum disulfide transistors coupled for logic and photo-inverter operation, **Journal of Materials Chemistry C**, **2**, 6023, (2014)
12. High-gain subnanowatt power consumption hybrid complementary logic inverter with WSe₂ nanosheet and ZnO nanowire transistors on glass **Advanced Materials**, **27**, 150 (2015)
13. Few layer MoS₂-organic thin film hybrid complementary inverter pixel fabricated on glass substrate **Small**, **11**, 2132 (2015)
14. Low Power Consumption Complementary Inverters with n-MoS₂ and p-WSe₂ Dichalcogenide Nanosheets on Glass for Logic and Light-Emitting Diode Circuits, **ACS Appl. Mater. Interfaces**, DOI: 10.1021/acsami.5b06027, (2015)

P-N and Schottky Diode

15. Multifunctional Schottky-diode circuit comprising palladium/molybdenum disulfide nanosheet, **Small**, **10**, 23, (2014)
16. Enhanced device performances of WSe₂-MoS₂ van der Waals junction p-n diode by fluoropolymer encapsulation **Journal of Materials Chemistry C**, **3**, 2751, (2015)

Memory FET

17. MoS₂ nanosheet channel and guanine DNA-base charge injection layer for high performance memory transistors **Journal of Materials Chemistry C**, **2**, 5411, (2014)
18. Nonvolatile Ferroelectric Memory Circuit Using Black Phosphorous Nanosheet-based Field Effect Transistors with P (VDF-TrFE) Polymer, **ACS Nano**, DOI: 10.1021/acsnano.5b04592, (2015)



Collaboration Groups & Acknowledgment

Acknowledgement

- National Research Foundation of Korea
National Research Laboratory: 2014R1A2A1A01004815,
Nano-Materials Technology Development: 2012M3A7B4034985)
- Yonsei University
Future-leading Research Initiative of 2014: 2014-22-0168
- Brain Korea 21 plus



Collaboration Groups

- LG Display & Samsung Display
- Dr. Won-Kook Choi (KIST - Optoelectronic Materials and Devices Post-Silicon Semiconductor)
- Prof. Takhee Lee (Seoul National Univ. - Dept. of Physics and Astronomy)
- Prof. Myung Mo Sung (Hanyang Univ. - Dept. of Chemistry)
- Prof. Jae Hoon Kim, Hyoung Joon Choi, Yeonjin Yi (Yonsei Univ. - Dept. of Physics)
- Prof. Hyungjun Kim, Jong-Hyun Ahn (Yonsei Univ. - Dept. EE)



Thank you for listening



E-mail: semicon@yonsei.ac.kr

Lab. Website: [Http://edlab.yonsei.ac.kr](http://edlab.yonsei.ac.kr)